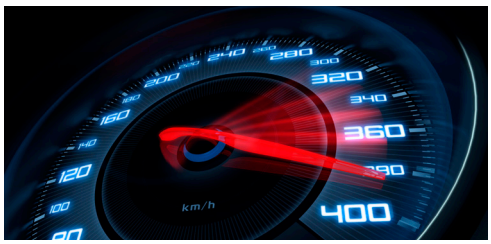
Discrete and Power Management

MICROCHIP

Power Discrete and Module Portfolio



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Contents

High-Voltage SMPS Transistors

Insulated Gate Bipolar Transistors (IGBTs) 3
IGBTs—Punch-Thru 4
IGBTs—Non-Punch-Thru 5
IGBTs—Field Stop 6
Silicon Carbide (SiC) MOSFETs 7
Power MOS 8™ MOSFETs/FREDFETs 8
Ultra-Fast, Low Gate Charge MOSFETs 10
Super Junction MOSFETs 11
Linear MOSFETs 11

Diodes

SiC Schottky Barrier Diodes 12
Si Schottky Barrier Diodes, Fast and Ultra-Fast Recovery Diodes 14

High-Voltage RF MOSFETs 16
High-Frequency RF MOSFETs 16
Drivers and Driver-RF MOSFET Hybrids 17
Reference Design Kits 17

Power Modules

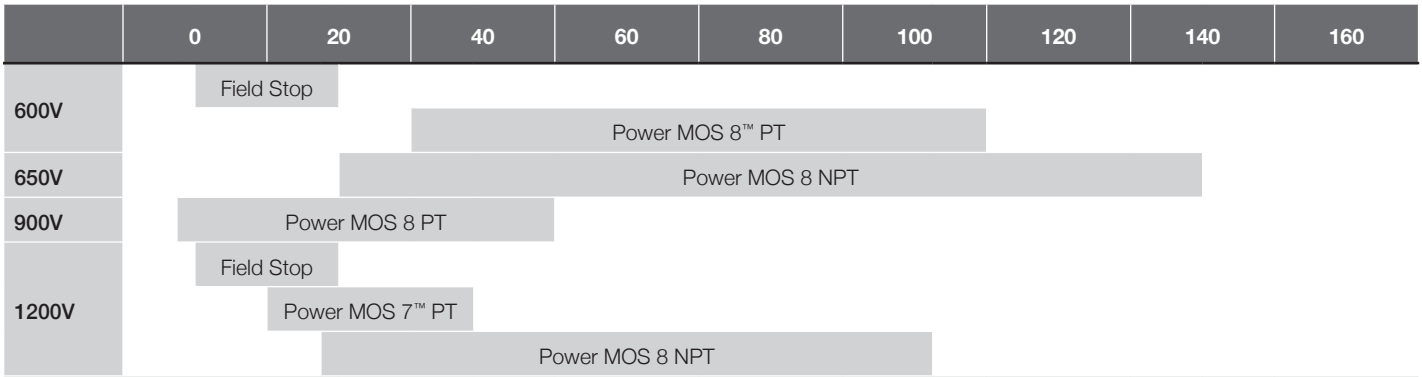
Power Modules Contents 18
Standard Electrical Configurations 19
Packaging 20
Custom Power Modules 21
Rugged Custom Power Modules 23
Power Module Part Numbering System 25
IGBT Power Modules 26
Intelligent Power Modules 29
MOSFET Power Modules 30
Renewable Energy Power Modules 34
Power Modules with SiC Schottky Diodes 36
SiC MOSFET Power Modules 38
Diode Power Modules 39

Package Outlines 40
Power Module Outlines 41

IGBTs From Microchip

IGBT products from Microchip provide high-quality solutions for a wide range of high-voltage and high-power applications. The switching frequency range spans from DC for minimal conduction loss to 150 kHz for very-high-power-density Switch Mode Power Supply (SMPS) applications. The frequency range for each product type is shown in the following graph. Each IGBT product represents the latest in IGBT technology, providing the best possible performance/cost combination for the targeted application. There are six product series that utilize three different IGBT technologies: Non-Punch-Through (NPT), Punch-Through (PT) and field stop.

IGBT Switching Frequency Ranges (kHz, Hard Switched)



Note: Frequency ranges shown are typical for a 50 A IGBT. Refer to product datasheet maximum frequency versus current graph for more information.

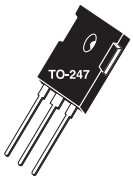
Standard Series	Voltage Ratings (V)	Technology	Easy to Parallel	Short Circuit Safe Operating Area (SOA)	Parameter
MOS 7™	1200	PT			Ultra-low gate charge
MOS 8™	600, 650, 900, 1200	PT, NPT			Highest efficiency
Field Stop Trench Gate	600, 1200	Field Stop	•	•	Lowest conduction loss

Product Options

All standard IGBT products are available as a single IGBT or as a Combi product packaged with an anti-parallel DQ series diode. Package options include TO-220, TO-247, T-MAX®, TO-264 and SOT-227. Customized products are available; contact the factory for details.

	$V_{(BR)CES}$ (V)	$V_{CE(ON)}$ (V) Typ 25°C	I_{C2} (A) 100°C	Maximum I_C (A) at Frequency		Part Number	Package Style
POWER MOS 7™	Single			20 kHz	40 kHz		
• **Ultra-low gate charge** • **Combi with high-speed DQ diode**	1200	3.3	33	19	12	APT25GP120BG	TO-247
		3.3	46	24	15	APT35GP120BG	TO-247
		3.3	54	29	18	APT45GP120BG	TO-247
		3.3	34	28	18	APT45GP120J	ISOTOP
		3.3	91	42	24	APT75GP120B2G	T-MAX®
		3.3	57	40	23	APT75GP120J	ISOTOP
	Combi (IGBT & "DQ" FRED)			20 kHz	40 kHz		
	1200	3.3	33	19	12	APT25GP120BDQ1G	TO-247
		3.3	46	24	15	APT35GP120B2DQ2G	T-MAX
		3.3	54	29	18	APT45GP120B2DQ2G	T-MAX
		3.3	34	28	18	APT45GP120JDQ2	ISOTOP®
		3.3	57	40	23	APT75GP120JDQ3	ISOTOP
POWER MOS 8™	Single			50 kHz	80 kHz		
• **Fast switching** • **Highest efficiency** • **Combi with high-speed DQ diode**	600	2	36	21	17	APT36GA60B	TO-247 or D3PAK
		2	44	26	20	APT44GA60B	TO-247 or D3PAK
		2	54	30	23	APT54GA60B	TO-247 or D3PAK
		2	68	35	27	APT68GA60B	TO-247 or D3PAK
		2	80	40	31	APT80GA60B	TO-247 or D3PAK
		2	102	51	39	APT102GA60B2	T-MAX or TO-264
				25 kHz	50 kHz		
	900	2.5	35	17	10	APT35GA90B	TO-247 or D3PAK
		2.5	43	21	13	APT43GA90B	TO-247 or D3PAK
		2.5	64	29	19	APT64GA90B	TO-247 or D3PAK
		2.5	80	34	23	APT80GA90B	TO-247 or D3PAK
	Combi (IGBT & "DQ" FRED)			50 kHz	80 kHz		
	600	2	36	21	17	APT36GA60BD15	TO-247 or D3PAK
		2	44	26	20	APT44GA60BD30	TO-247 or D3PAK
		2	54	30	23	APT54GA60BD30	TO-247 or D3PAK
		2	60	48	36	APT60GA60JD60	ISOTOP
		2	68	35	27	APT68GA60B2D40	T-MAX or TO-264
		2	80	40	31	APT80GA60LD40	TO-264
				25 kHz	50 kHz		
	900	2.5	27	14	8	APT27GA90BD15	TO-247 or D3PAK
		2.5	35	17	10	APT35GA90BD15	TO-247 or D3PAK
		2.5	43	21	13	APT43GA90BD30	TO-247 or D3PAK
		2.5	46	33	21	APT46GA90JD40	ISOTO
		2.5	64	29	19	APT64GA90B2D30	T-MAX or TO-264
		2.5	80	34	23	APT80GA90LD40	TO-264

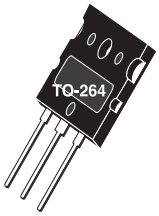
Part numbers for D3PAK packages—replace "B" with "S" in part number. Part numbers for TO-264 packages—replace "B2" with "L" in part number.



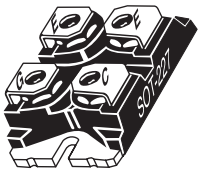
TO-247[B]

D3PAK[S]

T-MAX®[B2]



TO-264[L]



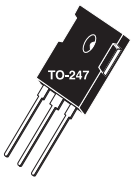
ISOTOP®[J]
SOT-227

Current at frequency test conditions: T_J = 125°C, T_C = 100°C except Isotop® where T_C = 80°C, V_{CC} = 67% rated voltage hard switch.

IGBTs—Non-Punch-Thru

	$V_{(BR)CES}$ (V)	$V_{CE(ON)}$ (V) Typ 25°C	I_{C2} (A) 100°C	Maximum I_C (A) at Frequency		Part Number	Package Style
POWER MOS 8™	Single			150 kHz	200 kHz		
		1.9	45	31	25	APT45GR65B	TO-247
				100 kHz	150 kHz		
	650	1.9	70	52	39	APT70GR65B	TO-247
				50 kHz	100 kHz		
		1.9	95	69	41	APT95GR65B2	T-MAX®
				50 kHz	80 kHz		
		2.5	25	25	21	APT25GR120B	TO-247
		2.5	25	25	21	APT25GR120S	D3PAK
		2.5	40	38	28	APT40GR120B	TO-247
		2.5	40	38	28	APT40GR120S	D3PAK
		2.5	50	48	36	APT50GR120B2	T-MAX
		2.5	50	48	36	APT50GR120L	TO-264
	1200			25 kHz	50 kHz		
		2.5	70	66	42	APT70GR120B2	T-MAX
		2.5	70	66	42	APT70GR120L	TO-264
		2.5	70*	42	30	APT70GR120J	ISOTOP®
• **High-speed switching**		2.5	85	72	46	APT85GR120B2	T-MAX
• **Low switching losses**		2.5	85	72	46	APT85GR120L	TO-264
• **Easy to parallel**		2.5	85*	46	31	APT85GR120J	ISOTOP
	Combi (IGBT & Diode)			150 kHz	200 kHz		
		1.9	45	31	25	APT45GR65BSCD10	TO-247 (SiC SBD)
	650			100 kHz	150 kHz		
		1.9	70	52	39	APT70GR65B2SCD30	T-MAX (SiC SBD)
				50 kHz	80 kHz		
		2.5	25	25	21	APT25GR120BD15	TO-247 (DQ)
		2.5	25	25	21	APT25GR120SD15	D3PAK (DQ)
		2.5	25	25	21	APT25GR120BSCD10	TO-247 (SiC SBD)
		2.5	25	25	21	APT25GR120SSCD10	D3PAK (SiC SBD)
	1200	2.5	40	38	28	APT40GR120B2D30	T-MAX (DQ)
		2.5	40	38	28	APT40GR120B2SCD10	T-MAX (SiC SBD)
				25 kHz	50 kHz		
		2.5	50*	42	32	APT50GR120JD30	ISOTOP (DQ)
		2.5	70*	42	30	APT70GR120JD60	ISOTOP (DQ)
		2.5	85*	46	31	APT85GR120JD60	ISOTOP (DQ)

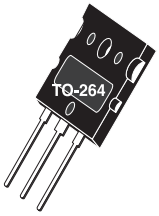
Part numbers for D3PAK packages—replace "B" with "S" in part number. Part numbers for TO-264 packages—replace "B2" with "L" in part number.



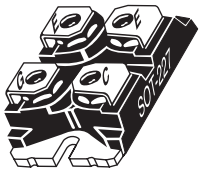
TO-247[B]

D3PAK[S]

T-MAX®[B2]



TO-264[L]

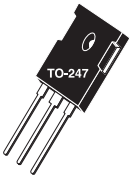


ISOTOP®[J]
SOT-227

Current at frequency test conditions: T_J = 125°C, T_C = 100°C except Isotop® where T_C = 80°C, V_{CC} = 67% rated voltage hard switch.

	$V_{(BR)CES}$ (V)	$V_{CE(ON)}$ (V) Typ 25°C	I_{C2} (A) 100°C	Maximum I_C (A) at Frequency		Part Number	Package Style
Field Stop	Single			15 kHz	30 kHz		
	600	1.5	24	15	10	APT20GN60BG	TO-247
		1.5	37	20	14	APT30GN60BG	TO-247
		1.5	64	30	21	APT50GN60BG	TO-247
		1.5	93	42	30	APT75GN60BG	TO-247
		1.5	123	75	47	APT150GN60J	ISOTOP®
		1.5	135	54	39	APT100GN60B2G	T-MAX®
		1.5	190	79	57	APT150GN60B2G	T-MAX
		1.5	230	103	75	APT200GN60B2G	T-MAX
		1.5	158	100	66	APT200GN60J	ISOTOP
	1200			10 kHz	20 kHz		
		1.7	33	19	13	APT25GN120BG	TO-247 or D3PAK
		1.7	46	24	17	APT35GN120BG	TO-247
		1.7	66	32	22	APT50GN120B2G	T-MAX
		1.7	70	44	27	APT100GN120J	ISOTOP
		1.7	99	45	30	APT75GN120B2G	T-MAX or TO-264
• **Trench technology** • **Short circuit rated** • **Lowest conduction loss** • **Easy paralleling** • **Combi with high-speed DQ diode**		1.7	120	58	38	APT100GN120B2G	T-MAX
		1.7	99	60	36	APT150GN120J	ISOTOP
	Combi (IGBT & "DQ" FRED)			15 kHz	30 kHz		
	600	1.5	24	15	10	APT20GN60BDQ1G	TO-247
		1.5	37	20	14	APT30GN60BDQ2G	TO-247
		1.5	64	30	21	APT50GN60BDQ2G	TO-247
		1.5	93	42	30	APT75GN60LDQ3G	TO-264
		1.5	123	75	47	APT150GN60JDQ4	ISOTOP
		1.5	135	54	39	APT100GN60LDQ4G	TO-264v
		1.5	190	79	57	APT150GN60LDQ4G	TO-264
		1.5	158	100	66	APT200GN60JDQ4	ISOTOP
	1200			10 kHz	20 kHz		
		1.7	22	14	10	APT15GN120BDQ1G	TO-247 or D3PAK
		1.7	33	19	13	APT25GN120B2DQ2G	T-MAX
		1.7	46	24	17	APT35GN120L2DQ2G	264-MAX™
		1.7	57	36	22	APT75GN120JDQ3	ISOTOP
		1.7	66	32	22	APT50GN120L2DQ2G	264-MAX
		1.7	70	44	27	APT100GN120JDQ4	ISOTOP
		1.7	99	60	36	APT150GN120JDQ4	ISOTOP

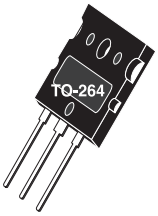
Part numbers for D3PAK packages—replace "B" with "S" in part number. Part numbers for TO-264 packages—replace "B2" with "L" in part number.



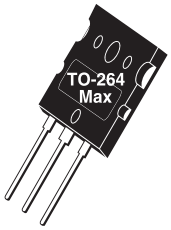
TO-247[B]

D3PAK[S]

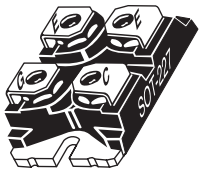
T-MAX®[B2]



TO-264[L]



264-MAX™[L2]



ISOTOP®[J]
SOT-227

Current at frequency test conditions: T_J = 125°C, T_C = 100°C except Isotop® where T_C = 80°C, V_{CC} = 67% rated voltage hard switch.

Silicon Carbide (SiC) MOSFETs

Silicon Carbide (SiC) is the ideal technology for higher switching frequency, higher efficiency, and higher power (>650V) applications. Target markets and applications include:

- Commercial aviation: actuation, air conditioning, power distribution
- Industrial: Motor drives, welding, Uniterruptible Power Supply (UPS), SMPS, induction heating
- Transportation/automotive: Electric Vehicle (EV) battery charger, Hybrid Electric Vehicle (HEV) powertrain, DC–DC converter, energy recovery
- Smart energy: PhotoVoltaic (PV) inverter, wind turbine
- Medical: MRI power supply, x-Ray power supply
- Defense and oil drilling: motor drives, auxiliary power supplies

SiC MOSFET and SiC Schottky barrier diode product lines from Microchip increase your system efficiency over silicon MOSFET and IGBT solutions while lowering your total cost of ownership by enabling downsized systems and smaller/lower cost cooling.

Part Number	Voltage (V)	$R_{DS(ON)}$ (mΩ)	I_D (Max at 25°C) (A)	Package
MSC090SMA070B	700	90	20	TO-247
MSC090SMA070S			19	D3PAK
MSC060SMA070B		60	35	TO-247
MSC060SMA070S			33	D3PAK
MSC035SMA070B		35	70	TO-247
MSC035SMA070S			62	D3PAK
MSC015SMA070B		15	141	TO-247
MSC015SMA070S			126	D3PAK
MSC080SMA120B	1200	80	33	TO-247
MSC080SMA120S			32	D3PAK
MSC080SMA120J			26	SOT-227
MSC040SMA120B		40	67	TO-247
MSC040SMA120S			64	D3PAK
MSC040SMA120J			53	SOT-227
MSC025SMA120B		25	103	TO-247
MSC025SMA120S			94	D3PAK
MSC025SMA120J			77	SOT-227
MSC750SMA170B	1700	750	5.0	TO-247
MSC750SMA170S			4.4	D3PAK
MSC045SMA170B		45	55	TO-247
MSC045SMA170S			50	D3PAK

TO-247

TO-268
D3PAK

SiC MOSFET Features and Benefits

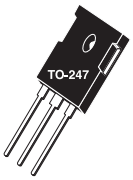
Characteristics	Results	Benefits
Breakdown field (MV/cm)	Lower on-resistance	Higher efficiency
Electron sat. velocity (cm/s)	Faster switching	Size reduction
Bandgap energy (ev)	Higher junction temperature	Improved cooling
Thermal conductivity (W/m.K)	Higher power density	Higher current capabilities
Positive temperature coefficient	Self regulation	Easy paralleling

Advantages Versus Competition

- Lowest conduction losses at high temperature
- Low switching losses
- High short circuit withstand rating
- Low gate resistance
- High avalanche rating: UIS and Repetitive UIS
- Patented SiC technology
- SiC is the perfect technology to address high-frequency and high-power-density applications
- Lower power losses
- Easier cooling, downsized system and higher reliability

BVDSS (V)	$R_{DS(ON)}$ Max (Ω)	I_D (A)	MOSFET Part Number	I_D (A)	FREDFET Part Number	Package Style
1200	2.40			7	APT7F120B	TO-247 or D3PAK
	2.10	8	APT7M120B			TO-247
	1.20			14	APT13F120B	TO-247 or D3PAK
	1.10	14	APT14M120B			TO-247
	0.70			23	APT22F120B2	T-MAX® or TO-264
	0.63	24	APT24M120B2			T-MAX or TO-264
	0.58			27	APT26F120B2	T-MAX or TO-264
	0.58			18	APT17F120J	ISOTOP®
	0.53	29	APT28M120B2			T-MAX or TO-264
	0.53	19	APT19M120J			ISOTOP
	0.32			33	APT32F120J	ISOTOP
	0.29	35	APT34M120J			ISOTOP
1000	2.00			7	APT7F100B	TO-247
	1.80	8	APT8M100B			TO-247
	1.60			9	APT9F100B	TO-247 or D3PAK
	1.40	9	APT9M100B			TO-247
	0.98			14	APT14F100B	TO-247 or D3PAK
	0.88	14	APT14M100B			TO-247 or D3PAK
	0.78			17	APT17F100B	TO-247 or D3PAK
	0.70	18	APT18M100B			TO-247
	0.44			30	APT29F100B2	T-MAX or TO-264
	0.44			20	APT19F100J	ISOTOP
	0.38	32	APT31M100B2	35	APT34F100B2	T-MAX or TO-264
	0.38	21	APT21M100J	23	APT22F100J	ISOTOP
	0.33	37	APT37M100B2			T-MAX or TO-264
	0.33	25	APT25M100J			ISOTOP
	0.20			42	APT41F100J	ISOTOP
	0.18	45	APT45M100J			ISOTOP
800	0.90			12	APT11F80B	TO-247 or D3PAK
	0.80	13	APT12M80B			TO-247
	0.58			18	APT17F80B	TO-247 or D3PAK
	0.53	19	APT18M80B			TO-247 or D3PAK
	0.43			23	APT22F80B	TO-247 or D3PAK
	0.39	25	APT24M80B			TO-247 or D3PAK
	0.24			41	APT38F80B2	T-MAX or TO-264
	0.21	43	APT41M80B2	47	APT44F80B2	T-MAX or TO-264
	0.21			31	APT29F80J	ISOTOP
	0.19	49	APT48M80B2			T-MAX or TO-264
	0.19	33	APT32M80J			ISOTOP
	0.11			57	APT53F80J	ISOTOP
	0.10	60	APT58M80J			ISOTOP

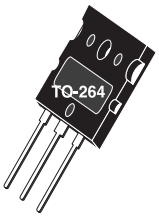
Part numbers for D3PAK packages—replace "B" with "S" in part number. Part numbers for TO-264 packages—replace "B2" with "L" in part number.



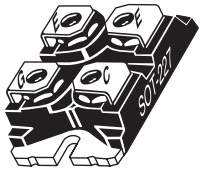
TO-247[B]

D3PAK[S]

T-MAX®[B2]



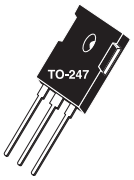
TO-264[L]



ISOTOP®[J]
SOT-227
(Isolated Base)

BVDSS (V)	$R_{DS(ON)}$ Max (Ω)	I_D (A)	MOSFET Part Number	I_D (A)	FREDFET Part Number	Package Style
600	0.37			19	APT18F60B	TO-247 or D3PAK
	0.29			24	APT23F60B	TO-247 or D3PAK
	0.19	36	APT34M60B	36	APT34F60B	TO-247
	0.15	45	APT43M60B2	45	APT43F60B2	T-MAX® or TO-264
	0.15	31	APT30M60J	31	APT30F60J	ISOTOP®
	0.11	60	APT56M60B2	60	APT56F60B2	T-MAX or TO-264
	0.11	42	APT39M60J	42	APT39F60J	ISOTOP
	0.09	70	APT66M60B2	70	APT66F60B2	T-MAX or TO-264
	0.09	49	APT47M60J	49	APT47F60J	ISOTOP
	0.055	84	APT80M60J	84	APT80F60J	ISOTOP
500	0.24			24	APT24F50B	TO-247 or D3PAK
	0.19			30	APT30F50B	TO-247 or D3PAK
	0.15			37	APT37F50B	TO-247 or D3PAK
	0.13			43	APT42F50B	TO-247 or D3PAK
	0.10	56	APT56M50B2	56	APT56F50B2	T-MAX or TO-264
	0.10	38	APT38M50J	38	APT38F50J	ISOTOP
	0.075	75	APT75M50B2	75	APT75F50B2	T-MAX or TO-264
	0.075	51	APT51M50J	51	APT51F50J	ISOTOP
	0.062	84	APT84M50B2	84	APT84F50B2	T-MAX or TO-264
	0.062	58	APT58M50J	58	APT58F50J	ISOTOP
	0.036	103	APT100M50J	103	APT100F50J	ISOTOP

Part numbers for D3PAK packages—replace "B" with "S" in part number. Part numbers for TO-264 packages—replace "B2" with "L" in part number.



TO-247[B]

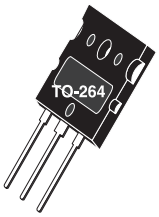
D3PAK[S]

T-MAX [B2]

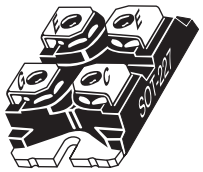
Low-Voltage Power MOS V® MOSFETs/FREDFETs

BVDSS (V)	$R_{DS(ON)}$ Max (Ω)	I_D (A)	MOSFET Part Number	I_D (A)	FREDFET Part Number	Package Style
300	0.085	40	APT30M85BVRG			TO-247
	0.070	48	APT30M70BVRG	48	APT30M70BVFRG	TO-247 or D3PAK
	0.040	70	APT30M40JVR	70	APT30M40JVFR	ISOTOP®
	0.019	130	APT30M19JVR	130	APT30M19JVFR	ISOTOP
200	0.045	56	APT20M45BVRG	56	APT20M45BVFRG	TO-247
	0.038	67	APT20M38BVRG			TO-247 or D3PAK
	0.022	100	APT20M22B2VRG			T-MAX® or TO-264
	0.011	175	APT20M11JVR	175	APT20M11JVFR	ISOTOP

Part numbers for D3PAK packages—replace "B" with "S" in part number. Part numbers for TO-264 packages—replace "B2" with "L" in part number.



TO-264[L]



ISOTOP®[J]
SOT-227
(Isolated Base)

For 250 kHz–2 MHz Switching Applications

The ultra-fast, low gate charge MOSFET family combines the lowest gate charge available in the industry with Microchip's proprietary self-aligned aluminum metal gate structure. The result is a MOSFET capable of extremely fast switching speeds and very-low switching losses. The metal gate structure and the layout of these chips provide an internal Series Gate Resistance (EGR) an order of magnitude lower than competitive devices built with a polysilicon gate.

These devices are ideally suited for high-frequency and pulsed high-voltage applications.

Typical Applications

- Class D amplifiers up to 2 MHz
- High-voltage pulsed DC
- AM transmitters
- Plasma deposition/etch

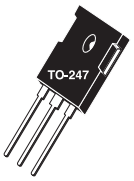
Features

- Series gate resistance (RG) <0.1Ω
- TR and TF times of <10 ns
- Industry's lowest gate charge

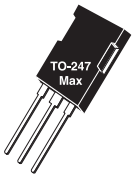
Benefits

- Fast switching, uniform signal propagation
- Pulse power applications
- Fast switching, reduced gate drive power

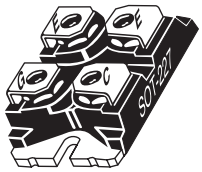
B_{VDSS} (V)	$R_{DS(ON)}$ Max (Ω)	I_D (A)	MOSFET Part Number	FREDFET Part Number	Package Style
1200	4.700	3.5		APT1204R7BFLLG	TO-247 or D3PAK
	1.400	9		APT1201R4BFLLG	TO-247
	0.570	22	APT12057B2LLG		T-MAX®
1000	0.900	12	APT10090BLLG		TO-247
	0.780	14	APT10078BLLG		TO-247 or D3PAK
	0.450	23	APT10045B2LLG		T-MAX or TO-264
	0.450	21	APT10045JLL		ISOTOP®
	0.350	28	APT10035B2LLG		T-MAX
	0.350	25	APT10035JLL		ISOTOP
	0.260	38		APT10026L2FLLG	TO-264 MAX
	0.260	30	APT10026JLL	APT10026JFLL	ISOTOP
	0.210	37	APT10021JLL	APT10021JFLL	ISOTOP
800	0.140	52	APT8014L2LLG	APT8014L2FLLG	TO-264 MAX
	0.110	51	APT8011JLL	APT8011JFLL	T-MAX or TO-264
	0.200	38	APT8020B2LL		T-MAX
	0.200	33	APT8020JLL		ISOTOP or D3PAK
500	0.140	35	APT5014BLLG		TO-247
	0.100	46	APT5010B2LLG	APT5010B2FLLG	T-MAX or TO-264
	0.065	67	APT50M65B2LLG	APT50M65B2FLLG	T-MAX or TO-264
	0.065	58	APT50M65JLL	APT50M65JFLL	ISOTOP
	0.075	51	APT50M75JLL	APT50M75JFLL	ISOTOP
	0.075	57	APT50M75B2LLG		T-MAX or TO-264
	0.050	71	APT50M50JLL		ISOTOP
	0.038	88	APT50M38JLL		ISOTOP



TO-247[B]



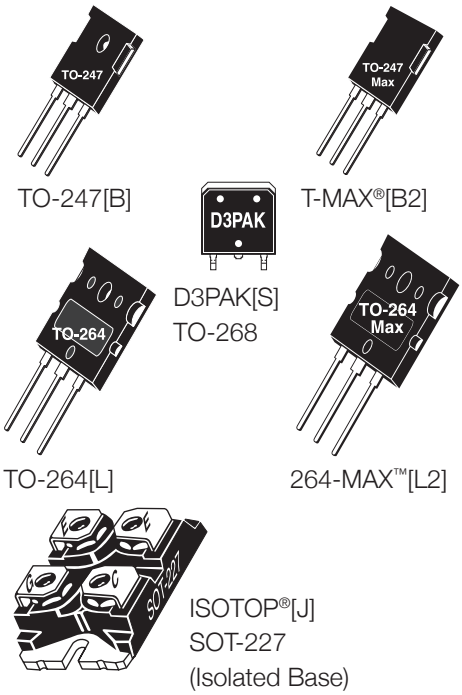
T-MAX®[B2]



ISOTOP®[J]
SOT-227
(Isolated Base)

B_{VDSS} (V)	$R_{DS(ON)}$ (Ω)	$I_{D(CONT)}$ (A)	Part Number	Package Style
		C3 Technology		
900	0.120	36	APT36N90BC3G	TO-247
	0.450	11	APT11N80BC3G	TO-247
800	0.145	34	APT34N80B2C3G	T-MAX® or TO-264
	0.145	34	APT34N80LC3G	TO-264
	0.035	94	APT94N65B2C3G	T-MAX or TO-264
650	0.070	47	APT47N65BC3G	TO-247 or D3PAK
	0.070	47	APT47N60BC3G	TO-247 or D3PAK
600	0.035	77	APT77N60JC3	ISOTOP®
	0.042	94	APT94N60L2C3G	264-MAX™
		Server Series		
	0.045	60	APT60N60BCSG	TO-247 or D3PAK
		C6 Technology		
	0.041	77	APT77N60BC6	TO-247 or D3PAK
	0.070	53	APT53N60BC6	TO-247 or D3PAK
600	0.099	38	APT38N60BC6	TO-247 or D3PAK
	0.125	30	APT30N60BC6	TO-247 or D3PAK
	0.035	106	APT106N60B2C6	T-MAX or TO-264
650	0.041	85	APT97N65B2C6	T-MAX or TO-264
	0.035	94	APT94N65B2C6	T-MAX

Part numbers for D3PAK packages—replace "B" with "S" in part number.



Linear MOSFETs

What is a Linear MOSFET?

A MOSFET specifically designed to be more robust than a standard MOSFET when operated with both high voltage and high current near DC conditions (>100 msecs).

The Problem with SMPS MOSFETs

MOSFETs optimized for high-frequency SMPS applications have poor high voltage DC SOA. Most SMPS-type MOSFETs over state SOA capability at high voltage on the datasheets. Above ~30V and DC conditions, SOA drops faster than is indicated by Power Disipation (PD) limited operation. For pulsed loads (t <10 ms), there is generally no problem using a standard MOSFET.

Technology Innovation

Introduced in 1999, Microchip modified its proprietary patented self-aligned metal gate MOSFET technology for enhanced performance in high voltage, linear applications.

These linear MOSFETs typically provide 1.5–2.0 times the DC SOA capability at high voltage compared to other MOSFET technologies optimized for switching applications.

A Design Will Need Linear MOSFETs in the Following Situations

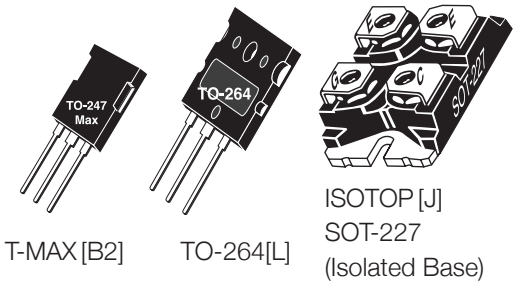
- High current and less than 200 volts at less than 100 milliseconds
- Used as a variable power resistor
- Soft start application (limit surge currents)
- Linear amplifier circuit

Typical Applications

- Active loads above 200 volts, such as DC dynamic loads for testing power supplies, batteries, fuel cells, etc.
- High voltage, high current, constant current sources

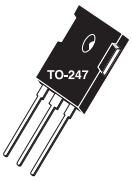
BV_{DSS} (V)	$R_{DS(ON)}$ (Ω)	$I_{D(CONT)}$ (A)	SOA (W)	Part Number
600	0.125	49	325	APL602B2G
	0.125	43	325	APL602J
500	0.090	58	325	APL502B2G
	0.090	52	325	APL502J

Part numbers for TO-264 packages—replace "B2" with "L" in part number.



Part Number	Voltage (V)	I_F (A)	V_F (V) (Typical at 25°C)	Package
MSC010SDA070B	700	10	1.5	TO-247
MSC010SDA070K		10	1.5	TO-220
MSC030SDA070B		30	1.5	TO-247
MSC030SDA070K		30	1.5	TO-220
MSC030SDA070S		30	1.5	D3PAK
MSC050SDA070B		50	1.5	TO-247
MSC050SDA070S		50	1.5	D3PAK
MSC010SDA120B	1200	10	1.5	TO-247
MSC010SDA120K		10	1.5	TO-220
MSC015SDA120B		15	1.5	TO-247
MSC030SDA120B		30	1.5	TO-247
MSC030SDA120B		30	1.5	TO-220
MSC030SDA120S		30	1.5	D3PAK
MSC050SDA120B		50	1.5	TO-247
MSC050SDA120S		50	1.5	D3PAK
MSC010SDA170B	1700	10	1.5	TO-247
MSC030SDA170B		30	1.5	TO-247
MSC050SDA170B		50	1.5	TO-247

TO-220[K]



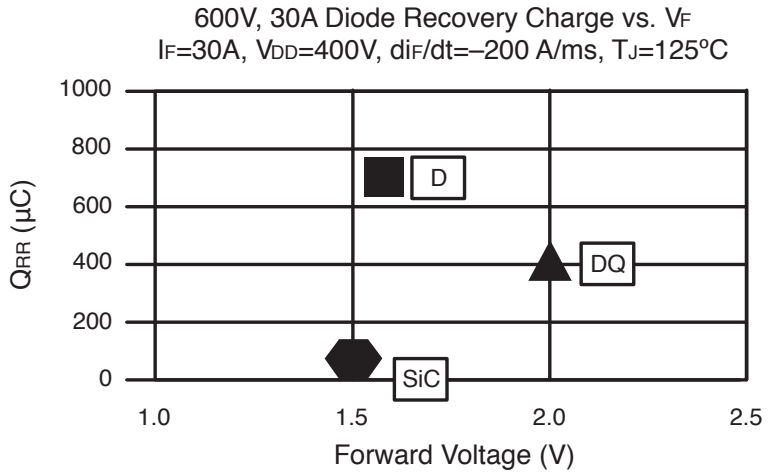
TO-247[B]

D3PAK[S]

Si Schottky Barrier Diodes, Fast and Ultra-Fast Recovery Diodes

Microchip offers four series of discrete diode products: the medium-speed medium V_F D series, the high-speed DQ series, the silicon Schottky S series and the SiC Schottky MSCxxxSDxxxx series. These series of diodes are designed to provide high-quality solutions to a wide range of high-voltage, high-power application requirements, ranging from fast recovery for continuous conduction mode power factor correction to low conduction loss for output rectification. The following table summarizes each product family's distinguishing features and potential applications.

The following graph shows the relative recovery speed and forward voltage positions of 600 V, D and DQ series diodes.



SiC Schottky Barrier Diodes

Series	Voltage Ratings	Features	Applications	Comment
D	200, 300, 400, 600, 1000, 1200	Medium V_F Medium speed	Freewheeling diode Output rectifier DC–DC converter	Proprietary platinum process
DQ	600, 1000, 1200	High speed Avalanche rated	PFC Freewheeling diode DC–DC converter	Stepped EPI improves softness Proprietary platinum process
Schottky	200	Low V_F Avalanche rated	Output rectifier Freewheeling diode DC–DC converter	
SiC Schottky	700, 1200, 1700	Zero reverse recovery	PFC Freewheeling diode DC–DC converter	Low switching losses, high power density and high-temperature operation

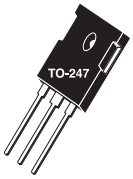
Si Schottky Barrier Diodes, Fast and Ultra-Fast Recovery Diodes

Volts	I (A)	Volts Typ 25°C	t(ns) Typ 25°C	Q(nC) RR Typ 125°C at $I_F = I_F$ (avg)	Diode Series	Part Number	Package
Single							
1200	15	2.8	21	960	DQ	APT15DQ120BG	TO-247
	15	2.8	21	960	DQ	APT15DQ120KG	TO-220
	15	2.0	32	1300	D	APT15D120BG	TO-247
	15	2.0	32	1300	D	APT15D120KG	TO-220
	30	2.8	24	1800	DQ	APT30DQ120BG	TO-247
	30	2.8	24	1800	DQ	APT30DQ120KG	TO-220
	30	2.0	31	3450	D	APT30D120BG	TO-247
	40	2.8	26	2200	DQ	APT40DQ120BG	TO-247
	60	2.8	30	2800	DQ	APT60DQ120BG	TO-247
	60	2.0	38	4000	D	APT60D120BG	TO-247 or D3PAK
	75	2.8	32	3340	DQ	APT75DQ120BG	TO-247
1000	15	2.5	20	810	DQ	APT15DQ100BG	TO-247
	15	2.5	20	810	DQ	APT15DQ100KG	TO-220
	15	1.9	28	1550	D	APT15D100KG	TO-220
	30	2.5	22	1250	DQ	APT30DQ100BG	TO-247
	30	2.5	22	1250	DQ	APT30DQ100KG	TO-247
	30	1.9	29	2350	D	APT30D100BG	TO-247
	40	2.5	24	1430	DQ	APT40DQ100BG	TO-247
	60	2.5	29	2325	DQ	APT60DQ100BG	TO-247
	60	1.9	34	3600	D	APT60D100BG	TO-247 or D3PAK
	75	2.5	33	2660	DQ	APT75DQ100BG	TO-247
600	15	2.0	16	250	DQ	APT15DQ60BG	TO-247
	15	2.0	16	250	DQ	APT15DQ60KG	TO-220
	15	1.6	21	520	D	APT15D60BG	TO-247
	15	1.6	21	520	D	APT15D60KG	TO-220
	30	2.0	19	400	DQ	APT30DQ60BG	TO-247
	30	2.0	19	400	DQ	APT30DQ60KG	TO-220
	30	1.6	23	700	D	APT30D60BG	TO-247
	40	2.0	22	480	DQ	APT40DQ60BG	TO-247
	60	2.0	26	640	DQ	APT60DQ60BG	TO-247
	60	1.6	40	920	D	APT60D60BG	TO-247 or D3PAK
	75	2.0	29	650	DQ	APT75DQ60BG	TO-247
400	30	1.3	22	360	D	APT30D40BG	TO-247
	60	1.3	30	540	D	APT60D40BG	TO-247
200	30	1.1	21	150	D	APT30D20BG	TO-247
	30	0.83	25	448	Schottky	APT30S20BG	TO-247 or D3PAK
	60	1.1	30	250	D	APT60D20BG	TO-247
	60	0.83	35	490	Schottky	APT60S20BG	TO-247 or D3PAK
	100	0.89	40	690	Schottky	APT100S20BG	TO-247

Part numbers for D3 package—replace "B" with "S" in part number.

TO-220[K]

D3PAK[S]
TO-268



TO-247[B]

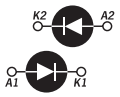
T-MAX [B2]

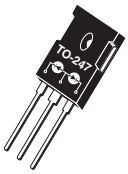
Si Schottky Barrier Diodes, Fast and Ultra-Fast Recovery Diodes

Volts	I (A)	Volts Typ 25°C	t(ns) Typ 25°C	Q(nC) RR Typ 125°C at $I_F = I_F$ (avg)	Diode Series	Part Number	Package
				Dual			
1200	2x27	2	31	3450	D	APT2X30D120J	ISOTOP®
	2x30	2.6	25	1800	DQ	APT2X30DQ120J	
	2x53	2.0	38	4000	D	APT2X60D120J	
	2x60	2.5	30	2890	DQ	APT2X60DQ120J	
	2x93	2.0	47	5350	D	APT2X100D120J	
	2x100	2.4	45	5240	DQ	APT2X100DQ120J	
1000	2x28	1.9	29	2350	D	APT2X30D100J	
	2x55	1.9	34	3600	D	APT2X60D100J	
	2x60	2.2	30	2350	DQ	APT2X60DQ100J	
	2x95	1.9	43	4050	D	APT2X100D100J	
	2x100	2.1	45	3645	DQ	APT2X100DQ100J	
600	2x30	1.8	20	400	DQ	APT2X30DQ60J	
	2x30	1.6	23	700	D	APT2X30D60J	
	2x60	1.7	27	650	DQ	APT2X60DQ60J	
	2x60	1.6	40	920	D	APT2X60D60J	
	2x100	1.6	30	980	DQ	APT2X100DQ60J	
	2x100	1.6	34	1450	D	APT2X100D60J	
400	2x30	1.3	22	360	D	APT2X30D40J	
	2x60	1.3	30	540	D	APT2X60D40J	
	2x100	1.3	37	1050	D	APT2X100D40J	
300	2x100	1.2	36	650	D	APT2X101D30J	
200	2x30	0.80	25	448	Schottky	APT2X31S20J	
	2x60	0.83	35	490	Schottky	APT2X61S20J	
	2x100	1.1	39	840	D	APT2X100D20J	
	2x100	0.89	40	690	Schottky	APT2X101S20J	
1200	2x30	2.8	26	2100	DQ	APT30DQ120BCTG	TO-247 [BCT]
1000	2x15	2.5	20	810	DQ	APT15DQ100BCTG	TO-247 [BCT]
	2x15	1.9	28	1550	D	APT15D100BCTG	TO-247 [BHB]
	2x30	1.9	29	2360	D	APT30D100BCTG	TO-247 [BHB]
	2x30	1.9	30	2350	D	APT30D100BHBG	TO-247 [BCA]
	2x60	2.5	29	2325	DQ	APT60DQ100LCTG	TO-264 [LCT]
600	2x60	1.9	35	3600	D	APT60D100LCTG	TO-264 [LCT]
	2x15	1.6	21	520	D	APT15D60BCTG	TO-247
	2x15	2.0	15	250	DQ	APT15DQ60BCTG	TO-247 [BCT]
	2x15	1.6	20	520	D	APT15D60BCAG	TO-247 [BCA]
	2x30	2.0	22	480	DQ	APT30DQ60BHBG	TO-247 [BHB]
	2x30	2.0	19	400	DQ	APT30DQ60BCTG	TO-247 [BCT]
	2x30	1.6	23	700	D	APT30D60BCTG	TO-247 [BCT]
	2x30	1.6	25	700	D	APT30D60BHBG	TO-247 [BHB]
	2x30	1.6	25	700	D	APT30D60BCAG	TO-247 [BCA]
	2x40	2.0	22	480	DQ	APT40DQ60BCTG	TO-247 [BCT]
	2x60	2.0	26	640	DQ	APT60DQ60BCTG	TO-247 [BCT]
	2x60	1.6	30	920	D	APT60D60LCTG	TO-264 [LCT]
400	2x30	1.3	22	360	D	APT30D40BCTG	TO-247 [BCT]
	2x60	1.3	30	540	D	APT60D40LCTG	TO-264 [LCT]
300	2x30	1.2	25	1300	D	APT30D30BCTG	TO-247 [BCT]
200	2x30	1.1	21	150	D	APT30D20BCTG	TO-247 [BCT]
	2x30	1.1	21	150	D	APT30D20BCAG	TO-247 [BCA]
	2x30	0.80	25	448	Schottky	APT30S20BCTG	TO-247 [BCT]
	2x60	0.83	35	490	Schottky	APT60S20B2CTG	T-MAX® [B2CT]
	2x100	0.89	40	690	Schottky	APT100S20LCTG	TO-264 [LCT]

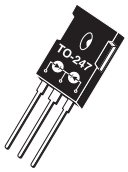
Part numbers for parallel configuration: replace 30, 60, or 100 with 31, 61, or 101, unless Schottky. Example: 2X30D120J becomes 2X31D120J. Part numbers for D3PAK packages—replace "B" with "S" in part number.

ISOTOP [J]
SOT-227
Antiparallel
Configuration
(Isolated Base)

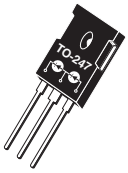




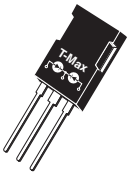
TO-247[BCA]
Common anode



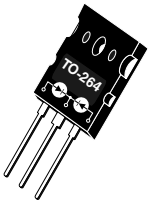
TO-247[BCT]
Common cathode



TO-247[BHB]
Half-bridge



T-MAX® [B2CT]
Common cathode

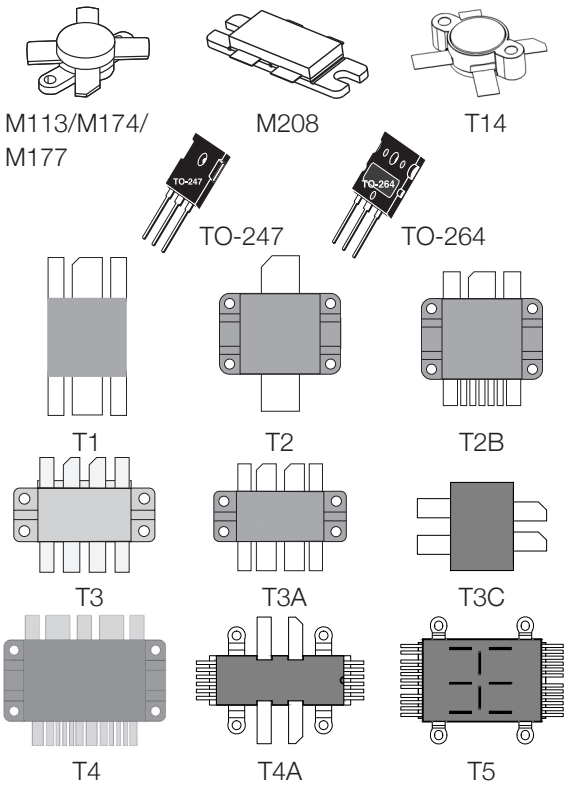


TO-264[LCT]
Common cathode

The ARF family of RF power MOSFETs is optimized for applications requiring frequencies as high as 150 MHz and operating voltages as high as 400V. Historically, RF power MOSFETs were limited to applications of 50V or less. This limitation has been removed by combining Microchip's high-voltage MOSFET technology with RF-specific die geometries.

Higher V_{DD} means higher load impedance. For 150W output from a 50V supply, the load impedance is only 8Ω. At 125V, the load impedance is 50Ω. The higher impedance allows simpler transformers and combiners. Paralleled devices can still operate into reasonable and convenient impedances. The increased operating voltage also lowers the DC current required for any given power output, increasing efficiency and reducing the size, weight and cost of other system components. High breakdown voltage is a necessity in high-efficiency switchmode amplifiers, such as class C-E, which can see peak drain voltages of over 4x the applied V_{DD}.

Part Number	P_{OUT} (W)	Freq. (MHz)	V_{DD}/BV_{DSS} (V)	Rth_{JC} (OC/W)	Package Style	Class of Operation
ARF449AG/BG	90	120	150/450	0.76	TO-247	A-E
ARF463AG/BG	100	100	125/500	0.7	TO-247	A-E
ARF463AP1G/BP1G	100	100	125/500	0.7	TO-247	A-E
ARF446G/ARF447G	140	65	250/900	0.55	TO-247	A-E
ARF521	150	150	165/500	0.6	M174	A-E
ARF460AG/BG	150	65	125/500	0.5	TO-247	A-E
ARF461AG/BG	150	65	250/1000	0.5	TO-247	A-E
ARF465AG/BG	150	60	300/1200	0.5	TO-247	A-E
ARF468AG/BG	270	45	165/500	0.38	TO-264	A-E
ARF475FL	300	150	165/500	0.31	T3A	A-E
ARF476FL	300	150	165/500	0.31	T3	A-E
ARF466AG/BG	300	45	200/1000	0.35	TO-264	A-E
ARF466FL	300	45	200/1000	0.13	T3A	A-E
ARF479	300	150	165/500	0.31	T3C	A-E
ARF469AG/BG	350	45	165/500	0.28	TO-264	A-E
ARF477FL	400	65	165/500	0.18	T3A	A-E
ARF1500	750	40	125/500	0.12	T1	A-E
ARF1501	750	40	250/1000	0.12	T1	A-E
ARF1510	750	40	700/1000	0.12	T1	D
ARF1511	750	40	380/500	0.12	T1	D
ARF1519	750	25	250/1000	0.13	T2	A-E



High-Frequency RF MOSFETs

The VRF family of RF MOSFETs includes improved replacements for industry-standard RF transistors. They provide improved ruggedness by increasing the BV_{DSS} over 30 percent from the industry-standard 125V to 170V minimum. Low-cost flangeless packages are another improvement that shows Microchip's dedication to optimizing performance, reducing cost and improving reliability. We will continue to offer more products with the new reduced-cost flangeless packages.

Part Number	P_{OUT} (W)	Freq. (MHz)	Gain Typ (dB)	Eff. Typ (%)	V_{DD}/BV_{DSS} (V)	Rth_{JC} (OC/W)	Package Style
VRF148A	30	175	16	50	65/170	1.52	M113
VRF141	150	175	13	45	28/80	0.60	M174
VRF151	150	175	14	50	65/170	0.60	M174
VRF152	150	175	14	50	50/140	0.60	M174
VRF150	150	150	11	50	65/170	0.60	M174
VRF161	200	175	25	50	65/170	0.50	M177
VRF151G	300	175	16	55	65/170	0.30	M208
VRF2933	300	150	25	50	65/170	0.27	M177
VRF2944	400	150	25	50	65/170	0.22	M177
VRF154FL	600	30	17	45	65/170	0.13	T2
VRF157FL	600	30	21	45	65/170	0.13	T2
VRF164FL	600	30	21	45	65/170	0.10	T2

Drivers and Driver-RF MOSFET Hybrids

The DRF1200/01 hybrids integrate drivers, bypass capacitors and RF MOSFETs into a single package. Integration maximizes amplifier performance by minimizing transmission line parasitics between the driver and the MOSFET. The DRF1300 and DRF1301 have two independent channels, each containing a driver and RF MOSFET in a push-pull configuration. The DRF1400 is a half-bridge hybrid with symmetrically oriented leads that can be eassily configured into a full-bridge converter. The new DRF1510 is a full bridge product optimized for maximum efficiency in class D amplifiers. All DRF parts feature a proprietary anti-ring function to eliminate cross conduction in bridge or push-pull topologies. All DRF parts can be externally selected in either an inverting or non-inverting configuration.

Part Number	P_{OUT} (W)	Freq. (MHz)	V_{DD}/BV_{DSS} (V)	Package Style	Class of Operation
DRF1200	400	30	15/1000	T2B	D-E
DRF1201	600	30	15/1000	T2B	D-E
DRF1300	1000	30	15/500	T4	D-E
DRF1301	1000	30	15/1000	T4	D-E
DRF1400	1000	30	15/500	T4	D-E
DRF1211	600	30	15/500	T2B	D-E
DRF1410	1000	30	15/500	T4A	D-E
DRF1510	2000	30	15/500	T5	D-E

Reference Designs

DRF1200/CLASS-E, 13.56 MHz DRF1200/ CLASS-E, 27.12 MHz

The DRF1200/Class-E single-ended RF generator is a reference design that allows the designer to evaluate an 85 percent efficient 1000 W Class-E RF generator.

DRF1300/CLASS-D, 13.56 MHz

The DRF1300/Class-D push-pull RF generator is a reference design that allows the designer to evaluate an 80-percent efficient 2000 W Class-D RF generator.

DRF1400/Class-D, 13.56 MHz

The DRF1400/Class-D half-bridge RF generator is a reference design that allows the designer to evaluate an 85-percent efficient 2500 W Class-D RF generator.

SiC Reference Designs

SiC SP6LI Module Driver Reference Design

- The MSCSICSP6/REF3 half bridge driver featuring brand new SP6LI (low inductance) power module with stray inductance < 3 nH to fully benefit from SiC and also designed to allow for easy paralleling.

SiC SP3 Module Driver Reference Design

- The MSCSICSP3/REF2 reference design provides an example of a highly isolated SiC MOSFET dual-gate driver for the SiC SP3 phase leg modules.

3-Phase Vienna PFC Reference Design for EV Chargers and Switch Mode Power Supplies

- 30 kW Vienna rectifier topology with greater than 98.5% peak efficiency
- 3-phase input 400 VAC/208 VAC, 50 Hz/60 Hz with output 780V DC
- IMSCSICPFC/REF5

Power Modules Contents

Microchip combines a formidable array of technologies in semiconductors, packaging and automated manufacturing to produce a wide range of high-quality modules optimized for the following traits:

- Reliability
- Efficiency and electrical performance
- Low cost
- Space savings
- Reduced assembly time

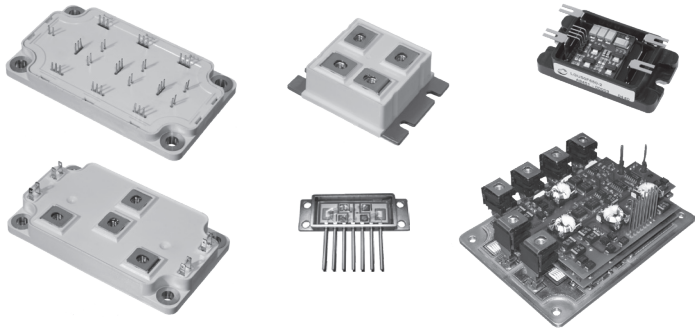
The readily available standard module product line spans a wide selection of semiconductor (including Silicon Carbide) circuit topologies, voltage and current ratings, and packages. If you need even more flexibility or intellectual property protection, we can customize a standard module with a low setup cost and short lead time. Unique requirements can be met with Application Specific Power Modules (ASPM).

Microchip serves a broad spectrum of industrial applications for welding, solar, induction heating, medical, UPS, motor control and SMPS markets as well as high-reliability applications for semicap, defense and aerospace markets. A wide selection of construction materials enables Microchip to manufacture modules with the following features:

- Extended temperature range: –60°C to 200°C
- High reliability
- Reduced size and weight
- High-reliability testing and screening options
- Short lead times

Microchip's experience and expertise in power electronic conversion brings the most effective technical support for your new development.

- Isolated gate driver
- Snubbers
- Mix-and-match semiconductors
- Short-circuit protection
- Temperature and current sensing
- Parameter binning



Standard Electrical Configurations

Microchip offers a wide range of standard electrical configurations housed in a variety of packages to match your specific needs for high power-density and performance. Various semiconductor types are offered in the same topology.

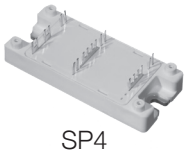
Electrical Topology	IGBT 600V–1700V	MOSFET 75V–1200V	Diode 200V–1700V	Mix Si-SiC 600V–1200V	Full SiC 600 to 1700V
Asymmetrical bridge	•	•			
Boost buck	•	•			
Boost and buck chopper	•	•		•	•
Common anode			•		
Common cathode			•		
Dual boost and buck chopper	•	•		•	
Dual common source	•	•			
Dual diode					•
Full bridge	•	•	•		•
Full bridge with PFC	•	•		•	
Full bridge with secondary fast rectifier bridge	•	•		•	
Full bridge with series and parallel diodes		•		•	
Interleaved PFC	•	•			
Linear single and dual switch		•			
Phase leg	•	•	•		•
Phase leg intelligent	•				
Phase leg with PFC		•		•	
Phase leg with series and parallel diodes		•		•	
Single switch	•	•	•		
Single switch with series and parallel diodes		•		•	
Single switch with series diodes	•	•			
3-Level NPC inverter	•				•
3-Level T-Type inverter	•			•	•
3-Phase bridge	•		•		
Triple dual common source	•	•			
Triple phase leg	•	•		•	•
	Trench3	MOSFET	FRED	IGBT	Diode
	Trench4	FREDFET	Std Rectifier	MOSFET	MOSFET
	Trench4 Fast	Super Junction Mosfet		Diode	
	Trench5				

Improved Low-Profile Packages

- SP1 (12 mm)
- SP3F (12 mm)
- SP4 (17 mm)
- SP6 (17 mm)
- SP6-P (12 mm)
- SP6LI (17 mm)

SP1

SP3F


SP4

D1P

SP6

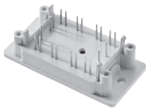
SP6-P

SP6LI

Industry-Standard Packages

- SOT-227 (ISOTOP)
- SP2 (17 mm)
- D3 (62 mm wide)
- D4 (62 mm wide)

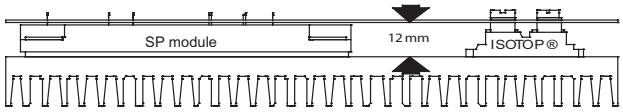
SOT-227


SP2

D3

D4

Package Advantages



30 mm

17 mm

SP1 package

- Replaces two SOT-227 parts
- Improved assembly time and cost
- Height compatible with SOT-227
- Copper base plate

SP3F package

- Replaces up to four SOT-227 parts
- Reduced assembly time and cost
- Height compatible with SOT-227
- Copper base plate

SP6 package

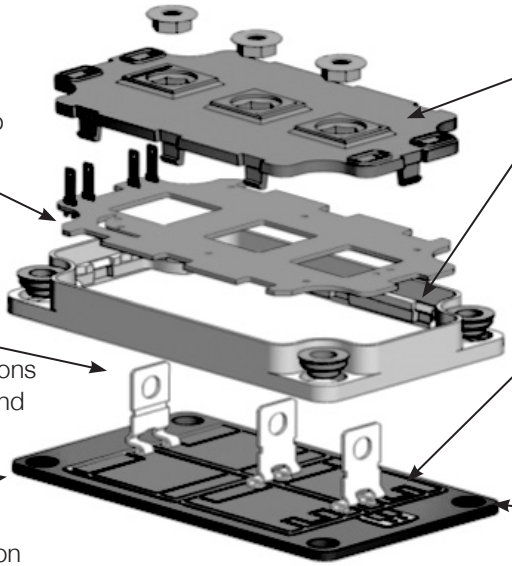
- Offers the same footprint and the same pinout location as the popular 62 mm package but with lower height, giving it the following advantages:
  - Reduced stray inductance
  - Reduced parasitic resistance
  - Higher efficiency at high frequency

SP6-P package

- Replaces up to six SOT-227 parts
- Height compatible with SOT-227
- Low-inductance solder pins
- High current capability

Custom Power Modules

Microchip created the ASPM concept, and has been offering customized power modules since 1983. We offer a complete engineered solution with mix-and-match capabilities in term of package, configuration, performance and cost.



Internal Printed Circuit Board

- Not available in all modules
- Used to route gate signals' tracks to small signal terminals
- Used to mount gate circuit and protection in case of intelligent power module

Terminals

- Screw-on or solder pins
- Provides power and signal connections with minimum parasitic resistance and inductance

Substrates

- Al_2O_3, AlN, and Si_3N_4 provide isolation and good heat transfer to the base plate

Package

- Standard or custom
- Ensures environmental protection and mechanical robustness

Power Semiconductor Die

- IGBT, MOSFET, diode, SiC, thyristor and switching devices soldered to the substrates and connected by ultrasonic aluminum wire bonds

Base Plate

- Improves the heat transfer to the heat sink
- Copper for good thermal transfer
- AlSiC, CuW and CuMoCu for improved reliability

The following table shows the three customization levels

Change Options:	Die	Substrate	Base Plate	Plastic Lid	Terminals	NRE Level	MOQ
Electrical/thermal performance	Die P/N	Material	Material			None to low	5 to 10 pieces
Electrical/thermal performance and electrical configuration	Die P/N	Material and layout	Material			Low to medium	
Electrical/thermal performance, and electrical configuration, and module housing	Die P/N	Material and layout	Material and shape	Material and shape	Shape	Medium to high	

Microchip power modules are made of different sub-elements. Most of them are standard and can be reused to build infinite solutions for the end user. Microchip offers optimum development cost and cycle time thanks to long-term experience and a wide range of available technologies.

Power Modules Features

- High power density
- Isolated and highly thermally-conductive substrate
- Internal wiring
- Minimum parasitics
- Minimum output terminals
- Mix-and-match components
- Fully engineered solutions

Customer Benefits

- Size and cost reduction
- Excellent thermal management
- Reduced external hardware
- Improved performance
- Reduced assembly time
- Optimizes losses
- Easy to upgrade, lower part count, shorter time to market and IP protection

Flexibility

- Great level of integration
- Mix of silicon within the same package
- No quantity limitation

Technology

- Application oriented

Packaging Capability

- Standard and custom packages
- Standard and custom terminals
- Various substrate technologies

Reliability

- Coefficient of thermal expansion matching

Applications

- Solar, welding, plasma cutting, semicap, MRI and X-ray, EV/HEV, induction heating, UPS, motor control, data communication

Rugged Custom Power Modules

Microchip has acquired much experience and know-how in module customization that addresses rugged and wide temperature range applications, offering solutions to meet the expectations of next-generation integrated power systems for the following attributes:

- Improved reliability
- Wider operating temperatures
- Higher power
- Higher efficiency
- Lower weight and size
- Lower cost

Applications

- Avionics actuation system
- Avionics lift and pump
- Military ground vehicle
- Power supply and motor control
- Navy ship auxiliary power supply
- Down hole drilling

Test Capabilities

- X-Ray inspection
- Dielectric test (up to 6 kV)
- Electrical testing at specified temperature
- Burn-in
- Acoustic imaging

Reliability Testing Capabilities

- Power cycling
- Hermetic sealing
- Moisture
- Salt atmosphere
- HTGB
- Temperature shock
- HAST
- H3TRB
- Altitude
- Mechanical shock, vibration

Expertise Capabilities

- Cross-sectioning
- Structural analysis

All tests can be conducted upon demand by sampling or at 100 percent. Tests can be performed in-house or in an external lab.

- Our Core Competencies
- Extensive experience with rugged solutions for harsh environments
- Wide range of silicon technologies
- Wafer fab capabilities
- Mix of assembly technologies
- Hermetic and robust plastic packages
- Custom test and burn-in solutions
- ISO9001-certified
- End-of-life (obsolescence) management
- Thermal management
- Material expertise
- Product life management and risk analysis

Various proposed solutions offer different costs and low volume of entry

	Industrial Application	Extended Temp. Application	Harsh Environment Application	
Standard module	•			No NRE Low-volume entry
Modified standard	•	•		Low NRE Low-volume entry
Custom module	•	•	•	Medium to high NRE Low-volume entry

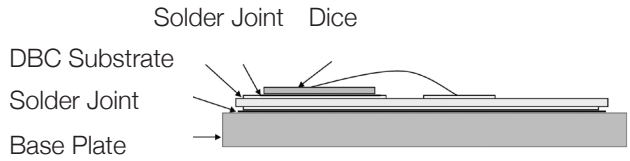
Module performance and reliability depends on the choice of assembly materials

Temperature Coefficients of Expansion (TCEs) with more closely matched materials increase the module's lifetime by reducing the stress at both the interface and interior of the materials.

The higher the thermal conductivity, the lower the junction-to-case thermal resistance and the lower the delta of junction temperature of the device during operation. This will minimize the effect of power cycling on the dice.

Another important feature is the material density, particularly for the baseplate. Taking copper as the reference, AlSiC has a density of 1/3, while CuW has twice the density. Therefore, AlSiC will provide substantial weight reduction while increasing reliability.

	CTE (ppm/K)	Thermal Conductivity (W/m.K)	$R_{\Theta JC}$ or R_{THJC} (K/W)
Silicon die (120 mm²)	4	136	
Cu/Al_2O_3	17/7	390/25	0.35
AlSiC/Al_2O_3	7/7	170/25	0.38
Cu/AlN	17/5	390/170	0.28
AlSiC/AlN	7/5	170/170	0.31
AlSiC/Si_3N_4	7/3	170/60	0.31



	Material	CTE (ppm/K) (W/m.K)	Thermal Conductivity	Density (g/cc)
Base plate	CuW	6.5	190	17
	AlSiC	7	170	2.9
	Cu	17	390	8.9
Substrate	Al_2O_3	7	25	
	AlN	5	170	
	Si_3N_4	3	60	
Die	Si	4	136	
	SiC	2.6	270	

Power Module Part Numbering System

IGBT Modules

APT MSC	GL	475	A	120	T	D3	G
I	II	III	IV	V	VI	VII	VIII

I TradeMark

II IGBT Type:
GL = TRENCH 4
GLQ = High-speed TRENCH 4
GT = TRENCH 3
GTQ = TRENCH 5
GV = Mix NPT/TRENCH
CV = Mix TRENCH/Super Junction MOSFET

III Current:
I_c at T_c = 80°C

IV Topology:
A = Phase Leg
BB = Boost Buck
DA = Boost Chopper
DDA = Double Boost Chopper
DH = Asymmetrical Bridge
DSK = Double Buck Chopper
DU = Dual Common Source
H = Full Bridge
HR = T-Type 3-Level
SDA = Double Boost + Bypass Diode
SK = Buck Chopper
TA = Triple Phase Leg
TDU = Triple Dual Common Source
TL = Three Level
U = Single Switch
VDA = Interleaved PFC
X = Three Phase Bridge

V Blocking Voltage:
60 = 600V
120 = 1200V
170 = 1700V

VI Option:
A = AlN Substrate
C = SiC Diode
D = Series Diode
T = Temperature Sensor
W = Clamping Parallel Diode

VII Package:
1 = SP1
2 = SP2
3 = SP3F
P = SP6-P
D3 = D3 (62 mm)
D4 = D4 (62 mm)

VIII G = RoHS-compliant

MOSFET Modules

APT MSC	C	60	DA	M24	T	1	G
I	II	III	IV	V	VI	VII	VIII

I TradeMark

II MOSFET Type:
MC - SM = MOSFET SiC
M = MOSFET
C = Super Junction MOSFET

III Blocking Voltage:
08 = 75V
10 = 100V
20 = 200V
50 = 500V
60 = 600V
80 = 800V
90 = 900V
100 = 100V
120 = 120V

IV Topology:
A = Phase Leg
BB = Boost Buck
DA = Boost Chopper
DDA = Double Boost Chopper
DH = Asymmetrical Bridge
DSK = Double Buck Chopper
DU = Dual Common Source
H = Full Bridge
HR = T-Type 3-Level
SDA = Double Boost and Bypass Diode
SK = Buck Chopper
TA = Triple Phase Leg
TDU = Triple Dual Common Source
TL = Three Level NPC
U = Single Switch
VDA = Interleaved PFC

V RDSON at T_c = 25°C
240 = 2400 mΩ
24 = 240 mΩ
M24 = 24 mΩ

VI Option:
A = AlN Substrate
C = SiC Diode
D = Series Diode
F = FREDFET
S = Series and Parallel Diodes
T = Temperature Sensor
U = Ultra-fast FREDFET

VII Package:
1 = SP1
2 = SP2
3 = SP3F
P = SP6-P
LI = SP6LI

VIII G = RoHS-compliant

Diode Modules

APT MSC	DR	90	X	160	1	G
I	II	III	IV	V	VI	VII

I TradeMark

II Diode Type:
DF = FRED
DR = Standard Rectifier
DC = SiC
DSK = Schottky

III Current:
I_F at T_c =80°C

IV Topology:
AA = Dual Common Anode
BB = Boost Buck
AK = Dual Series
KK = Dual Common Cathode
H = Single Phase Bridge
U = Single Switch
X = Three Phase Bridge

V Blocking Voltage:
20 = 200V
40 = 400V
60 = 600V
100 = 1000V
120 = 1200V
160 = 1600V
170 = 1700V

VI Package:
1 = SP1
3 = SP3F
D1P = D1P

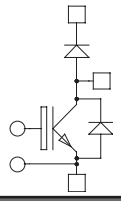
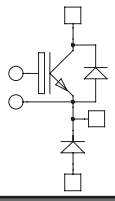
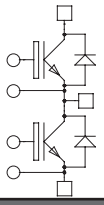
VII G = RoHS-compliant

Optional Materials

Optional materials are available upon demand for most of the listed standard power modules. Options are indicated with a letter in the suffix of the module part number. The temperature sensor option is listed as “YES” or “OPTION” when available for a standard part or on-demand.

The following tables list the options available for our product categories.

A	AlN substrate for higher thermal conductivity
M	AlSiC base plate material for improved temperature cycling capabilities
T	Temperature sensor (NTC or PTC) for case temperature information
C	SiC diode for higher efficiency
N	Si_3N_4 substrate
E	Press fit terminals (for SP3F package only)
X	Gold pin terminals (SP1 only)
L	Phase change material option

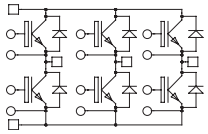




Chopper and Phase Leg

$V_{(BR)CES}$ (V)	IGBT Type	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	...DA... or ...U2	...SK... or ...U3	...A...
600	TRENCH 3	75	1.5	SP1	YES	APTGT75DA60T1G		APTGT75A60T1G
		100	1.5	SP1	YES	APTGT100DA60T1G		APTGT100A60T1G
		150	1.5	SP1	YES	APTGT150DA60T1G	APTGT150SK60T1G	APTGT150A60T1G
		150	1.5	SP3F	YES			APTGT150A60T3AG
		200	1.5	SP2	–			APTGT200A602G
		200	1.5	SP3F	YES	APTGT200DA60T3AG	APTGT200SK60T3AG	APTGT200A60T3AG
		300	1.5	SP4	YES			APTGT300A60TG
		300	1.5	SP6	OPTION	APTGT300DA60G	APTGT300SK60G	APTGT300A60G
		300	1.5	D3	OPTION	APTGT300DA60D3G	APTGT300SK60D3G	APTGT300A60D3G
		400	1.5	D3	OPTION	APTGT400DA60D3G		APTGT400A60D3G
		450	1.5	SP6	OPTION	APTGT450DA60G	APTGT450SK60G	APTGT450A60G
		600	1.5	SP6	OPTION	APTGT600DA60G	APTGT600SK60G	APTGT600A60G
650	TRENCH 4 FAST	50	1.85	SOT227		APT50GLQ65JU2		
		50	1.85	SOT227		APT100GLQ65JU2	APT100GLQ65JU3	
		100	1.85	SP1	YES			APTGLQ100A65T1G
		600	1.85	SP6	YES			APTGLQ600A65T6G
650	TRENCH 5	60	1.65	SP1	YES	APTGTQ100DA65T1G	APTGTQ100SK65T1G	APTGTQ100A65T1G
		120	1.65	SP3F	YES	APTGTQ200DA65T3G	APTGTQ200SK65T3G	APTGTQ200A65T3G
1200	TRENCH 3	35	1.7	SP1	YES			APTGT35A120T1G
		35	1.7	SOT227	–	APT35GT120JU2	APT35GT120JU3	
		50	1.7	SOT227	–	APT50GT120JU2	APT50GT120JU3	
		50	1.7	SP1	YES			APTGT50A120T1G
		50	1.7	SP4	YES	APTGT50DA120TG	APTGT50SK120TG	
		75	1.7	SOT227	–	APT75GT120JU2	APT75GT120JU3	
		75	1.7	SP1	YES			APTGT75A120T1G
		75	1.7	SP4	YES	APTGT75DA120TG	APTGT75SK120TG	
		100	1.7	SP1	YES	APTGT100DA120T1G		
		100	1.7	SOT227	–	APT100GT120JU2	APT100GT120JU3	
		100	1.7	SP3F	YES			APTGT100A120T3AG
		100	1.7	SP4	YES			APTGT100A120TG
		150	1.7	SP6	OPTION	APTGT150DA120G	APTGT150SK120G	APTGT150A120G
		150	1.7	SP3F	YES			APTGT150A120T3AG
		150	1.7	SP4	YES			APTGT150A120TG
		200	1.7	SP6	OPTION	APTGT200DA120G	APTGT200SK120G	APTGT200A120G
		200	1.7	D3	OPTION	APTGT200DA120D3G		APTGT200A120D3G
		300	1.7	SP6	OPTION	APTGT300DA120G	APTGT300SK120G	APTGT300A120G
		300	1.7	D3	OPTION			APTGT300A120D3G
		400	1.7	SP6	OPTION	APTGT400DA120G	APTGT400SK120G	APTGT400A120G
		400	1.7	D3	OPTION			APTGT400A120D3G
1200	TRENCH 4	40	1.85	SOT227	–	APT40GL120JU2	APT40GL120JU3	
		90	1.85	SP1	YES	APTGL90DA120T1G		APTGL90A120T1G
		180	1.85	SP2	–			APTGL180A1202G
		180	1.85	SP3F	YES			APTGL180A120T3AG
		325	1.85	D3	OPTION			APTGL325A120D3G
		475	1.85	D3	OPTION	APTGL475DA120D3G	APTGL475SK120D3G	APTGL475A120D3G
		700	1.85	D3	OPTION	APTGL700DA120D3G	APTGL700SK120D3G	
	TRENCH 4 FAST	100	2.05	SP3F	YES			APTGLQ100A120T3AG
		100	2.05	SP1	YES	APTGLQ100DA120T1G		
		100	2.05	SP4	YES			APTGLQ100A120TG
		150	2.05	SP4	YES			APTGLQ150A120TG
		200	2.05	SP3F	YES			APTGLQ200A120T3AG
		300	2.05	SP6C			APTGLQ300SK120G	APTGLQ300A120G
		400	2.05	SP6	YES			APTGLQ400A120T6G
1700	TRENCH 3	30	2	SP1	YES			APTGT30A170T1G
		50	2	SP1	YES		APTGT50SK170T1G	APTGT50A170T1G
		50	2	SP4	YES		APTGT50SK170TG	APTGT50A170TG
		100	2	SP4	YES		APTGT100SK170TG	APTGT100A170TG
		150	2	SP6	OPTION		APTGT150SK170G	
		200	2	D3	OPTION			APTGT200A170D3G
		225	2	SP6	OPTION	APTGT225DA170G	APTGT225SK170G	APTGT225A170G
		300	2	SP6	OPTION	APTGT300DA170G	APTGT300SK170G	APTGT300A170G
		300	2	D3	OPTION	APTGT300DA170D3G		APTGT300A170D3G

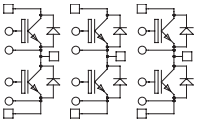
Three-Phase Bridge

$V_{(BR)CES}$ (V)	IGBT Type	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Part Number
600	Trench 3	30	1.5	SP3F	Yes	APTGT30X60T3G
		50	1.5	SP3F	Yes	APTGT50X60T3G
		75	1.5	SP3F	Yes	APTGT75X60T3G
1200	Trench 3	25	1.7	SP3F	Yes	APTGT25X120T3G
		35	1.7	SP3F	Yes	APTGT35X120T3G
	Trench 4	40	1.85	SP3F	Yes	MSCGL40X120T3AG
		40	1.85	SP3F	Yes	APTGL40X120T3G



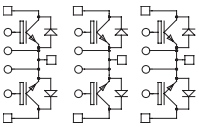
Three-Phase Leg

$V_{(BR)CES}$ (V)	IGBT Type	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Part Number
600	Trench 3	50	1.5	SP6-P	Option	APTGT50TA60PG
		150	1.5	SP6-P	Option	APTGT150TA60PG
650	Trench 5	30	1.65	SP3F	Yes	APTGTQ50TA65T3G
		90	1.65	SP6-P	Yes	APTGTQ150TA65TPG
1200	Trench 3	75	1.7	SP6-P	Option	APTGT75TA120PG
		100	1.7	SP6-P	Yes	APTGT100TA120TPG
	Trench 4	120	1.85	SP6-P	Yes	APTGL120TA120TPG



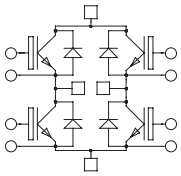
Triple Dual Common Source

$V_{(BR)CES}$ (V)	IGBT Type	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Part Number
600	Trench 3	50	1.5	SP6-P	Option	APTGT50TDU60PG
		75	1.5	SP6-P	Option	APTGT75TDU60PG
		100	1.5	SP6-P	Option	APTGT100TDU60PG
		150	1.5	SP6-P	Option	APTGT150TDU60PG
1200	Trench 3	75	1.7	SP6-P	Option	APTGT75TDU120PG
	Trench 4	120	1.85	SP6-P	Yes	APTGL120TDU120TPG
1700	Trench 3	50	2	SP6-P	Option	APTGT50TDU170PG

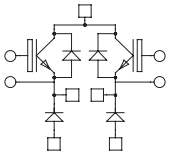


Dual Chopper

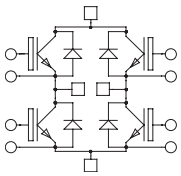
$V_{(BR)CES}$ (V)	IGBT Type	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package	NTC	...DDA...	...DSK...
600	Trench 3	50	1.5	SP3F	Yes	APTGT50DDA60T3G	
		75	1.5	SP3F	Yes	APTGT75DDA60T3G	
650	Trench 5	60	1.65	SP3F	Yes	APTGTQ100DDA65T3G	
	Trench 4 Fast	50	1.85	SP3F	Yes	APTGLQ50DDA65T3G	
	Trench 4 Fast	50	1.85	SP3F	Yes	APTGLQ50VDA65T3G	
1200	Trench 3	50	1.7	SP3F	Yes	APTGT50DDA120T3G	
	Trench 4	60	1.85	SP3F	Yes	APTGL60DDA120T3G	
		90	1.85	SP3F	Yes	APTGL90DDA120T3G	APTGL90DSK120T3G

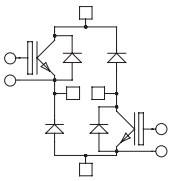


DDA



DSK



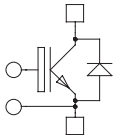


Full and Asymmetrical

V(BR)CES (V)	IGBT Type	IC (A) TC = 80°C	VCE (ON) (V) at Rated IC	Package (see page 20)	NTC	...H...	...DH...
600	TRENCH 3	20	1.5	SP1	YES	APTGT20H60T1G	
		30	1.5	SP1	YES	APTGT30H60T1G	
		50	1.5	SP1	YES	APTGT50H60T1G	APTGT50DH60T1G
		50	1.5	SP3F	YES	APTGT50H60T3G	
		75	1.5	SP1	YES	APTGT75H60T1G	
		75	1.5	SP2	YES	APTGT75H60T2G	
		75	1.5	SP3F	YES	APTGT75H60T3G	
		100	1.5	SP4	YES	APTGT100H60TG	APTGT100DH60TG
		100	1.5	SP3F	YES	APTGT100H60T3G	
		150	1.5	SP4	YES	APTGT150H60TG	APTGT150DH60TG
		200	1.5	SP6		APTGT200H60G	APTGT200DH60G
		300	1.5	SP6		APTGT300H60G	APTGT300DH60G
650	TRENCH 4 FAST	30	1.95	SP3F	YES	APTGLQ30H65T3G	
		50	1.85	SP1	YES	APTGLQ50H65T1G	
		50	1.85	SP3F	YES	APTGLQ50H65T3G	
		75	1.85	SP1	YES	APTGLQ75H65T1G	
		100	1.85	SP3F	YES	APTGLQ100H65T3G	
		200	1.85	SP6C		APTGLQ200H65G	
		300	1.85	SP6	OPTION	APTGLQ300H65G	
650	TRENCH 5	60	1.65	SP3F	YES	APTGTQ100H65T3G	
1200	TRENCH 3	35	1.7	SP3F	YES	APTGT35H120T3G	
		50	1.7	SP3F	YES	APTGT50H120T3G	
		50	1.7	SP4	YES		APTGT50DH120TG
		75	1.7	SP3F	YES		APTGT75DH120T3G
		75	1.7	SP4	YES	APTGT75H120TG	
		100	1.7	SP4	YES		APTGT100DH120TG
		100	1.7	SP6		APTGT100H120G	
		150	1.7	SP6		APTGT150H120G	APTGT150DH120G
		200	1.7	SP6		APTGT200H120G	APTGT200DH120G
	TRENCH 4	40	1.85	SP1	YES	APTGL40H120T1G	
		60	1.85	SP3F	YES	APTGL60H120T3G	
		90	1.85	SP3F	YES	APTGL90H120T3G	
	TRENCH 4 FAST	25	2.05	SP1	YES	APTGLQ25H120T1G	
		25	2.05	SP2	YES	APTGLQ25H120T2G	
		40	2.05	SP1	YES	APTGLQ40H120T1G	
		75	2.05	SP3F	YES	APTGLQ75H120T3G	
		75	2.05	SP4	YES	APTGLQ75H120TG	
		150	2.05	SP6C		APTGLQ150H120G	
		200	2.05	SP6	OPTION	APTGLQ200H120G	
1700	TRENCH 3	30	2	SP3F	YES	APTGT30H170T3G	
		50	2	SP4	YES	APTGT50H170TG	APTGT50DH170TG
		100	2	SP6		APTGT100H170G	
		150	2	SP6		APTGT150H170G	APTGT150DH170G

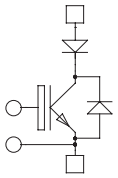
Single Switch

V_{CES} (V)	IGBT Type	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Part Number
600	Trench 3	750	1.5	D4	No	APTGT750U60D4G
1200	Trench 3	400	1.7	D4	No	APTGT400U120D4G
		600	1.7	D4	No	APTGT600U120D4G
	Trench 4	475	1.85	D4	No	APTGL475U120D4G
		700	1.85	D4	No	APTGL700U120D4G
1700	Trench 3	400	2	D4	No	APTGT400U170D4G
		600	2	D4	No	APTGT600U170D4G



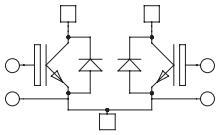
Single Switch + Series Diode

V_{CES} (V)	IGBT Type	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Part Number
1200	Trench 4	475	1.85	SP6	No	APTGL475U120DAG



Dual Common Source

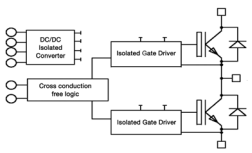
V_{CES} (V)	IGBT Type	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Part Number
600	Trench 3	100	1.5	SP4	Yes	APTGT100DU60TG
		200	1.5	SP4	Yes	APTGT200DU60TG
		300	1.4	SP6	No	APTGT300DU60G
		600	1.4	SP6	No	APTGT600DU60G
1200	Trench 3	50	1.7	SP4	Yes	APTGT50DU120TG
		75	1.7	SP4	Yes	APTGT75DU120TG
		100	1.7	SP4	Yes	APTGT100DU120TG
		150	1.7	SP6	No	APTGT150DU120G
		150	1.7	SP4	Yes	APTGT150DU120TG
		200	1.7	SP6	No	APTGT200DU120G
		300	1.7	SP6	No	APTGT300DU120G
		400	1.7	SP6	No	APTGT400DU120G
1700	Trench 3	100	2	SP4	Yes	APTGT100DU170TG
		225	2	SP6	No	APTGT225DU170G
		300	2	SP6	No	APTGT300DU170G



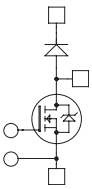
Intelligent Power Modules

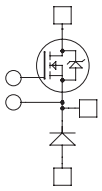
Phase Leg

Vces (V)	IGBT Type	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Part Number
600	Trench 3	400	1.5	LP8	No	APTLGT400A608G
1200	Trench 3	300	1.7	LP8	No	APTLGT300A1208G
	Trench 4	325	1.8	LP8	No	APTLGL325A1208G



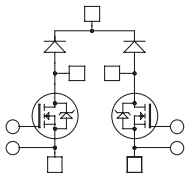
Chopper

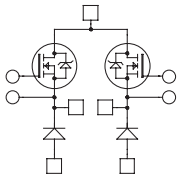




V_{DSS} (V)	MOSFET Type	$R_{DS(on)}$ (mΩ)	I_D (A) T_C = 80°C	Package (see page 20)	NTC	DA...or...U2	SK...or...U3
100	MOS 5	11	100	SOT-227	No	APT10M11JVRU2	APT10M11JVRU3
		4.5	207	SP4	Yes	APTM10DAM05TG	APTM10SKM05TG
		2.25	370	SP6	No	APTM10DAM02G	APTM10SKM02G
200	MOS 5	22	71	SOT-227	No	APT20M22JVRU2	APT20M22JVRU3
	MOS 7™	8	147	SP4	Yes	APTM20DAM08TG	APTM20SKM08TG
		5	250	SP6	Option	APTM20DAM05G	
		4	300	SP6	Option	APTM20DAM04G	APTM20SKM04G
500	MOS 5	100	30	SOT-227	No	APT5010JVRU2	APT5010JVRU3
	MOS 7	100	30	SOT-227	No	APT5010JLLU2	APT5010JLLU3
		75	32	SOT-227	No	APT50M75JLLU2	APT50M75JLLU3
		19	125	SP6	Option	APTM50DAM19G	APTM50SKM19G
		17	140	SP6	Option	APTM50DAM17G	APTM50SKM17G
	MOS 8™	65	43	SOT-227	No	APT58M50JU2	APT58M50JU3
600	Super Junction MOSFET	70	40	SOT-227	No	APT40N60JCU2	APT40N60JCU3
		24	70	SP1	Yes		APTC60SKM24T1G
900		120	25	SOT-227	No	APT33N90JCU2	APT33N90JCU3
		60	44	SP1	Yes	APTC90DAM60T1G	APTC90SKM60T1G
1000	MOS 7	180	33	SP4	Yes	APTM100DA18TG	
		90	59	SP6	Option	APTM100DAM90G	
	MOS 8	330	17	SP1	Yes	APTM100DA33T1G	APTM100SK33T1G
1200	MOS 8	300	23	SP1	Yes	APTM120DA30T1G	

Dual Chopper

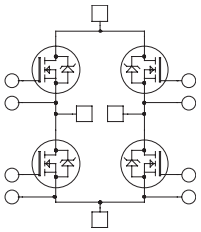




V_{DSS} (V)	MOSFET Type	$R_{DS(on)}$ (mΩ)	I_D (A) T_C = 80°C	Package (see page 20)	NTC	...DDA...	...DSK...
100	MOS 5	19	50	SP3F	Yes		APTM10DSKM19T3G
		9	100	SP3F	Yes		APTM10DSKM09T3G
500	MOS 7™	100	24	SP3F	Yes	APTM50DDA10T3G	
		65	37	SP3F	Yes	APTM50DDAM65T3G	
600	Super Junction MOSFET	45	38	SP1	Yes	APTC60DDAM45T1G	
		70	29	SP1	Yes	APTC60DDAM70T1G	
		35	54	SP3F	Yes	APTC60DDAM35T3G	
		24	70	SP3F	Yes	APTC60DDAM24T3G	APTC60DSKM24T3G
800		150	21	SP3F	Yes	APTC80DDA15T3G	
1000	MOS 7	350	17	SP3F	Yes		APTM100DSK35T3G

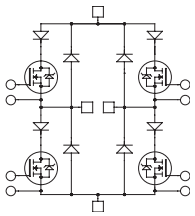
Full Bridge

V_{DSS} (V)	MOSFET Type	$R_{DS\ (ON)}$ (mΩ)	I_D (A) T_C = 80°C	Package	NTC	Part Number
100	FREDFET 5	4.5	207	SP6	No	APTM10HM05FG
		19	50	SP3F	Yes	APTM10HM19FT3G
		9	100	SP3F	Yes	APTM10HM09FT3G
200	FREDFET 7	20	62	SP4	Yes	APTM20HM20FTG
		16	74	SP4	Yes	APTM20HM16FTG
		10	125	SP6	No	APTM20HM10FG
		8	147	SP6	No	APTM20HM08FG
500	FREDFET 7	140	18	SP3F	Yes	APTM50H14FT3G
		100	24	SP3F	Yes	APTM50H10FT3G
		75	32	SP4	Yes	APTM50HM75FTG
		75	32	SP3F	Yes	APTM50HM75FT3G
		65	37	SP4	Yes	APTM50HM65FTG
		65	37	SP3F	Yes	APTM50HM65FT3G
		38	64	SP6	No	APTM50HM38FG
		35	70	SP6	No	APTM50HM35FG
	FREDFET 8	150	19	SP1	Yes	APTM50H15FT1G
600	Super Junction MOSFET	70	29	SP1	Yes	APTC60HM70T1G
		45	38	SP1	Yes	APTC60HM45T1G
		83	21	SP2	Yes	APTC60HM83FT2G
		70	29	SP3F	Yes	APTC60HM70T3G
		35	54	SP3F	Yes	APTC60HM35T3G
		24	70	SP3F	Yes	APTC60HM24T3G
	FREDFET 8	230	15	SP1	Yes	APTM60H23FT1G
800	Super Junction MOSFET	150	21	SP1	Yes	APTC80H15T1G
		290	11	SP3F	Yes	APTC80H29T3G
		150	21	SP3F	Yes	APTC80H15T3G
900		120	23	SP1	Yes	APTC90H12T1G
		60	44	SP3F	Yes	APTC90HM60T3G
1000	FREDFET 7	450	14	SP3F	Yes	APTM100H45FT3G
		350	17	SP4	Yes	APTM100H35FTG
		350	17	SP3F	Yes	APTM100H35FT3G
		180	33	SP6	No	APTM100H18FG
	FREDFET 8	460	14	SP3F	Yes	APTM100H46FT3G
1200	FREDFET 7	290	25	SP6	No	APTM120H29FG
	FREDFET 8	1400	6	SP1	Yes	APTM120H140FT1G



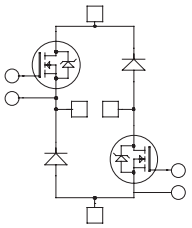
Full Bridge + Series and Parallel

V_{DSS} (V)	MOSFET Type	$R_{DS\ (ON)}$ (mΩ)	I_D (A) T_C = 80°C	Package	NTC	Part Number
200	MOS 7™	20	62	SP4	Yes	APTM20HM20STG
500	MOS 7	75	32	SP4	Yes	APTM50HM75STG
1000	MOS 7	450	13	SP4	Yes	APTM100H45STG



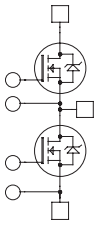
Asymmetrical Bridge

V_{DSS} (V)	MOSFET Type	$R_{DS\ (ON)}$ (mΩ)	I_D (A) T_C = 80°C	Package	NTC	Part Number
100	MOS5	4.5	207	SP6	No	APTM10DHM05G
500	MOS 7™	38	64	SP6	No	APTM50DHM38G
600	Super Junction MOSFET	24	70	SP3F	Yes	APTC60DHM24T3G



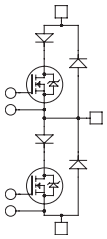
Phase Leg

V_{DSS} (V)	MOSFET Type	$R_{DS\ (ON)}$ (mΩ)	I_D (A) T_C = 80°C	Package (see page 20)	NTC	Part Number
100	FREDFET 5	4.5	207	SP4	Yes	APTM10AM05FTG
		2.25	370	SP6	Option	APTM10AM02FG
200	FREDFET 7	10	125	SP4	Yes	APTM20AM10FTG
		8	147	SP4	Yes	APTM20AM08FTG
		5	250	SP6	Option	APTM20AM05FG
		5	280	LP8		MSCM20AM058G
		4	300	SP6	Option	APTM20AM04FG
500	FREDFET 7	38	64	SP4	Yes	APTM50AM38FTG
		35	70	SP4	Yes	APTM50AM35FTG
		19	125	SP6	Option	APTM50AM19FG
		17	140	SP6	Option	APTM50AM17FG
600	Super Junction MOSFET	45	38	SP1	Yes	APTC60AM45T1G
		35	54	SP1	Yes	APTC60AM35T1G
		24	70	SP1	Yes	APTC60AM24T1G
		24	70	SP2	No	APTC60AM242G
	FREDFET 8	110	30	SP1	Yes	APTM60A11FT1G
900	Super Junction MOSFET	60	44	SP1	Yes	APTC90AM60T1G
1000	FREDFET 7	180	33	SP4	Yes	APTM100A18FTG
		90	59	SP6	Option	APTM100AM90FG
1200	FREDFET 7	290	25	SP4	Yes	APTM120A29FTG
		150	45	SP6	Option	APTM120A15FG



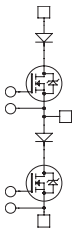
Phase Leg + Series and Parallel

V_{DSS} (V)	MOSFET Type	$R_{DS\ (ON)}$ (mΩ)	I_D (A) T_C = 80°C	Package (see page 20)	NTC	Part Number
200	MOS 7™	10	125	SP4	Yes	APTM20AM10STG
		6	225	SP6	No	APTM20AM06SG
500	MOS 7	38	64	SP4	Yes	APTM50AM38STG
		24	110	SP6	No	APTM50AM24SG
1000	MOS 7	230	26	SP4	Yes	APTM100A23STG
		130	49	SP6	No	APTM100A13SG
1200	MOS 7	200	37	SP6	No	APTM120A20SG



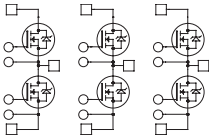
Phase Leg + Series Diodes

V_{DSS} (V)	MOSFET Type	$R_{DS\ (ON)}$ (mΩ)	I_D (A) T_C = 80°C	Package (see page 20)	NTC	Part Number
1000	MOS 7™	130	49	SP6	No	APTM100A13DG
1200	MOS 7	200	37	SP6	No	APTM120A20DG



Triple Phase Leg

V_{DSS} (V)	MOSFET Type	$R_{DS\ (ON)}$ (mΩ)	I_D (A) T_C = 80°C	Package (see page 20)	NTC	Part Number
75	MOSFET	4.2	90	SP6-P	Option	APTM08TAM04PG
100	FREDFET 5	19	50	SP6-P	Option	APTM10TAM19FPG
		9	100	SP6-P	Option	APTM10TAM09FPG
200	FREDFET 7	16	74	SP6-P	Option	APTM20TAM16FPG
500	FREDFET 7	65	37	SP6-P	Option	APTM50TAM65FPG
600	Super Junction MOSFET	35	54	SP6-P	Option	APTC60TAM35PG
		24	70	SP6-P	Yes	APTC60TAM24TPG
800		150	21	SP6-P	Option	APTC80TA15PG
900		60	44	SP6-P	Yes	APTC90TAM60TPG
1000	FREDFET 7	350	17	SP6-P	Option	APTM100TA35FPG

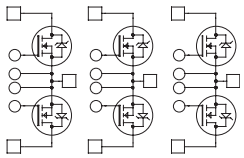


Three-Phase Bridge

VDSS (V)	MOSFET Type	RDS (ON) (mÙ)	ID (A) TC = 80°C	Package	NTC	Part Number
200	FREDFET 5	16	77	SP4		MSCM20XM16F4G
	FREDFET 5	10	84	SP3X		MSCM20XM10T3XG

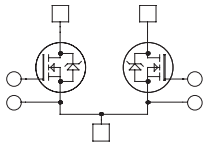
Triple Dual Common Source

VDSS (V)	MOSFET Type	RDS (ON) (mΩ)	ID (A) TC = 80°C	Package (see page 20)	NTC	Part Number
600	Super Junction	35	54	SP6-P	Option	APTC60TDUM35PG
800	MOSFET	150	21	SP6-P	Option	APTC80TDU15PG



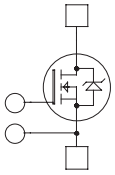
Dual Common Source

VDSS (V)	MOSFET Type	RDS (ON) (mΩ)	ID (A) TC = 80°C	Package (see page 20)	NTC	Part Number
100	MOS 5	2.25	370	SP6	No	APTM10DUM02G
200	MOS 7™	8	147	SP4	Yes	APTM20DUM08TG
		5	250	SP6	No	APTM20DUM05G
		4	300	SP6	No	APTM20DUM04G
1200	MOS 7	150	45	SP6	No	APTM120DU15G



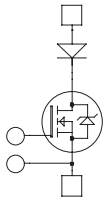
Single Switch

VDSS (V)	MOSFET Type	RDS (ON) (mΩ)	ID (A) TC = 80°C	Package (see page 20)	NTC	Part Number
100	FREDFET 5	2.25	430	SP6	Option	APTM10UM02FAG
		1.5	640	SP6	Option	APTM10UM01FAG
200	FREDFET 7	3	434	SP6	Option	APTM20UM03FAG
500	FREDFET 7	9	371	SP6	Option	APTM50UM09FAG
1000	FREDFET 7	60	97	SP6	Option	APTM100UM60FAG
		45	160	SP6	Option	APTM100UM45FAG
1200	FREDFET 7	70	126	SP6	Option	APTM120UM70FAG



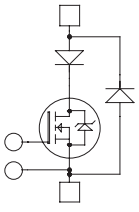
Single Switch + Series Diode

VDSS (V)	MOSFET Type	RDS (ON) (mΩ)	ID (A) TC = 80°C	Package (see page 20)	NTC	Part Number
1000	MOS 7™	65	110	SP6	No	APTM100UM65DAG
		45	160	SP6	No	APTM100UM45DAG
1200	MOS 7	70	126	SP6	No	APTM120UM70DAG



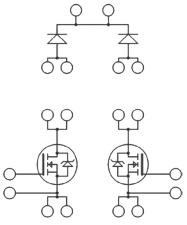
Single Switch + Series and Parallel

VDSS (V)	MOSFET Type	RDS (ON) (mΩ)	ID (A) TC = 80°C	Package (see page 20)	NTC	Part Number
200	MOS 7™	4	310	SP6	Option	APTM20UM04SAG
500	MOS 7	13	250	SP6	Option	APTM50UM13SAG
1000	MOS 7	65	110	SP6	Option	APTM100UM65SAG
1200	MOS 7	100	86	SP6	Option	APTM120U10SAG



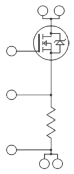
Interleaved PFC

VDSS (V)	MOSFET Type	RDS (ON) (mΩ)	ID (A) TC = 80°C	Package (see page 20)	NTC	Part Number
600	Super Junction MOSFET	45	38	SP1	Yes	APTC60VDAM45T1G
		24	70	SP3F	Yes	APTC60VDAM24T3G



Single and Dual Linear MOSFET

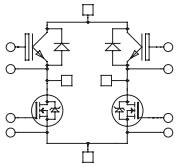
V_{DSS} (V)	MOSFET Type	$R_{DS\ (ON)}$ (mΩ)	Shunt Resistor (mR)	Package (see page 20)	NTC	Part Number
600	MOS4 Linear	125	20	SP3F	Yes	APTML602U12R020T3AG
1000	MOS4 Linear	600	20	SP1	Yes	APTML100U60R020T1AG



Renewable Energy Power Modules

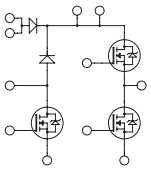
Full Bridge

V_{CES} (V)	Technology	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Part Number
600	Mix Trench IGBT & Super Junction MOSFET	50	83MR/1.5	SP1	Yes	APTCV40H60CT1G
		50	45MR/1.5	SP3F	Yes	APTCV50H60T3G



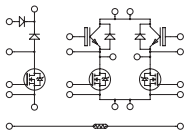
PFC + Bypass Diode + Phase Leg

V_{CES} (V)	Technology	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Special	Part Number
600	Super Junction MOSFET	38	45MR	SP1	N/A	10 A PFC SiC Diode	APTC60AM45BC1G
		38	45MR	SP1	N/A		APTC60AM45B1G
		27	83MR	SP1	N/A	10 A PFC SiC Diode	



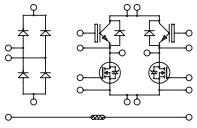
PFC + Bypass Diode + Full Bridge

V_{CES} (V)	Technology	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Special	Part Number
600	Mix Trench IGBT & Super Junction MOSFET	38	1.5/45MR	SP3F	Yes	20 A PFC SiC Diode	APTCV60HM45BC20T3G
		38	1.5/45MR	SP3F	Yes		APTCV60HM45BT3G
	Super Junction MOSFET	29	70MR	SP3F	Yes		APTC60HM70BT3G



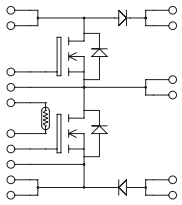
Secondary Fast Rectifier + Full Bridge

V_{CES} (V)	Technology	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Special	Part Number
600	Mix Trench IGBT & Super Junction MOSFET	38	1.5/45MR	SP3F	Yes	20 A SiC Antiparallel Diode	APTCV60HM45RCT3G
		38	1.5/45MR	SP3F	Yes		APTCV60HM45RT3G
	Super Junction MOSFET	29	70MR	SP3F	Yes		APTC60HM70RT3G
	Trench 3	50	1.5	SP3F	Yes		APTGT50H60RT3G



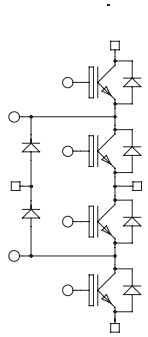
Boost Buck

V_{CES} (V)	Technology	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Part Number
600	Super Junction MOSFET	70	24MR	SP3F	Yes	APTC60BBM24T3G
	Trench 3	100	1.5	SP3F	Yes	APTGT100BB60T3G

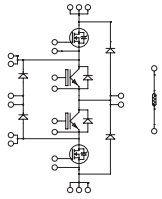


Three-Level NPC Inverter

V_{CES} (V)	Technology	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Part Number
600	Trench 3	20	1.5	SP1	No	APTGT20TL601G
		30	1.5	SP1	No	APTGT30TL601G
		50	1.5	SP3F	Yes	APTGT50TL60T3G
		50	1.5	SP1	No	APTGT50TL601G
		75	1.5	SP3F	Yes	APTGT75TL60T3G
		100	1.5	SP3F	Yes	APTGT100TL60T3G
		150	1.5	SP6	No	APTGT150TL60G
		200	1.5	SP6	No	APTGT200TL60G
		300	1.5	SP6	No	APTGT300TL60G
650	Trench 3	300	1.5	SP6	No	APTGT300TL65G
		400	1.5	SP6	No	APTGT400TL65G
	Trench 4 Fast	50	1.85	SP3F	Yes	APTGLQ50TL65T3G
1200	Trench 4	60	1.85	SP3F	Yes	APTGL60TL120T3G
		240	1.8	SP6	No	APTGL240TL120G
1700	Trench 3	100	2	SP6	No	APTGT100TL170G

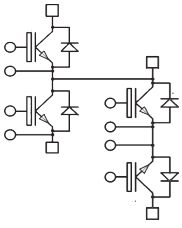


V_{CES} (V)	Technology	$R_{DS\ (ON)}$ Super Junction MOSFET (mΩ)	$V_{CE\ (ON)}$ IGBT (V)/ I_C (A)	Package (see page 20)	NTC	Part Number
600	Mix Trench IGBT and Super Junction MOSFET	24	1.5/75	SP3F	Yes	APTCV60TLM24T3G
		45	1.5/75	SP3F	Yes	APTCV60TLM45T3G
		70	1.5/50	SP3F	Yes	APTCV60TLM70T3G
		99	1.5/30	SP3F	Yes	APTCV60TLM99T3G
900		120	1.85/50	SP3F	Yes	APTCV90TL12T3G



T-Type 3-Level Inverter

V_{CES} (V)	Technology	I_C (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Special	Part Number
600/1200	Trench 4 Fast	40	2.05	SP3F	Yes	10A/600 V SiC	APTGLQ40HR120CT3G
		80	2.05	SP3F	Yes	30A/600 V SiC	APTGLQ80HR120CT3G
		200	2.05	SP6	No		APTGLQ200HR120G



Vienna Rectifier

VCES (V)	IGBT Type	IC (A) TC = 80°C	VCE (on) (V) at Rated Ic	Package	NTC	Part Number
600	SUPER JUNCTION MOSFET	19	99mR	SP3F	YES	MSCC60VRM99CT3AG
		40	45mR	SP6-P	YES	MSCC60VRM45TAPG
		81	23mR	SP4		MSCC60AM23C4AG
650	TRENCH 5	80	1.65	SP1		MSCGTQ100HD65C1AG
900	SiC MOSFET	110	12mR	SP3F		MSCMC90AM12C3AG

Power Modules with SiC Schottky Diodes

SiC Schottky diodes offer superior dynamic and thermal performance over conventional silicon power diodes. The main advantages of the SiC Schottky diodes are:

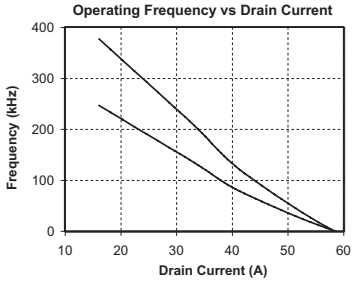
- Essentially zero forward and reverse recovery—reduced switch and diode switching losses
- Temperature independent switching behavior—stable high temperature performance
- Positive temperature coefficient of VF—ease of parallel operation
- Usable 175°C junction temperature—safely operate at higher temperatures

Extremely fast switching of SiC Schottky diode enables designs with:

- Improved system efficiency
- Higher reliability
- Lower system switching losses
- Lower system cost
  - Smaller EMI filter
  - Smaller magnetic components
  - Smaller heat-sink
  - Smaller switches, eliminates snubbers
  - Reduced system size
  - Fewer/smaller components

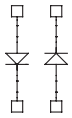
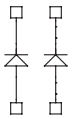
Applications

- PFC
- Output rectification
- Solar inverter
- Motor control
- Snubber diode



Diode Power Modules with SiC Diodes

Dual Diode

VRRM (V)	DIODE Type	IF (A) TC = 100°C	VF (V) TJ = 25°C	Package	Anti-Parallel	Parallel
700	SiC	50	1.5	SOT-227	MSC2X50DC70J	MSC2X51DC70J
		100	1.5	SOT-227	MSC2X100DC70J	MSC2X101DC70J
1200	SiC	20	1.5	SOT-227	MSC2X20DC120J	MSC2X21DC120J
		40	1.5	SOT-227	MSC2X40DC120J	MSC2X41DC120J
		50	1.5	SOT-227	MSC2X50DC120J	MSC2X51DC120J
		60	1.5	SOT-227	MSC2X60DC120J	MSC2X61DC120J
		100	1.5	SOT-227	MSC2X100DC120J	MSC2X101DC120J

Full Bridge

V_{RRM} (V)	DIODE Type	IF (A) TC = 100°C	VF (V) TJ = 25°C	Package	Part Number
700	SiC	50	1.5	SP1	MSCDC50H701AG
		50	1.5	SOT-227	MSC50DC70HJ
		100	1.5	SP6C	MSCDC100H70AG
		200	1.5	SP6C	MSCDC200H70AG
1200	SiC	50	1.5	SP1	MSCDC50H1201AG
		50	1.5	SOT-227	MSC50DC120HJ
		100	1.5	SP6C	MSCDC100H120AG
		200	1.5	SP6C	MSCDC200H120AG

Phase Leg

VRRM (V)	DIODE Type	IF (A) TC = 100°C	VF (V) TJ = 25°C	Package	Part Number
700	SiC	100	1.5	D1P	MSCDC100A70D1PAG
		150	1.5	D1P	MSCDC150A70D1PAG
		200	1.5	D1P	MSCDC200A70D1PAG
		300	1.5	SP6C	MSCDC300A70AG
		450	1.5	SP6C	MSCDC450A70AG
		600	1.5	SP6C	MSCDC600A70AG
1200	SiC	100	1.5	D1P	MSCDC100A120D1PAG
		150	1.5	D1P	MSCDC150A120D1PAG
		200	1.5	D1P	MSCDC200A120D1PAG
		300	1.5	SP6C	MSCDC300A120AG
		450	1.5	SP6C	MSCDC450A120AG
		600	1.5	SP6C	MSCDC600A120AG

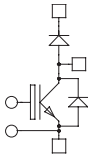
Dual Common Cathode

VRRM (V)	DIODE Type	IF (A) TC = 100°C	VF (V) TJ = 25 °C	Package	Part Number
700	SiC	100	1.5	D1P	MSCDC100KK70D1PAG
		150	1.5	D1P	MSCDC150KK70D1PAG
		200	1.5	D1P	MSCDC200KK70D1PAG
1200	SiC	100	1.5	D1P	MSCDC100KK120D1PAG
		150	1.5	D1P	MSCDC150KK120D1PAG
		200	1.5	D1P	MSCDC200KK120D1PAG

3-Phase Bridge

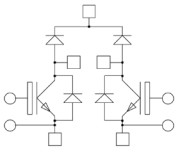
VRRM (V)	DIODE Type	IF (A) TC = 100°C	VF (V) TJ = 25°C	Package	Part Number
700	SiC	50	1.5	SP1	MSCDC50X701AG
1200	SiC	50	1.5	SP1	MSCDC50X1201AG

Boost Chopper



V_{RRM} (V)	IGBT Type	I_D (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Part Number
1200	Trench 4 Fast	25	2.05	SOT-227	No	APT25GLQ120JCU2
		40	2.05	SOT-227	No	APT40GLQ120JCU2

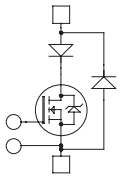
Dual Chopper



V_{RRM} (V)	IGBT Type	I_D (A) T_C = 80°C	$V_{CE\ (ON)}$ (V) at Rated I_C	Package (see page 20)	NTC	Part Number
1200	Trench 4 Fast	40	2.05	SP3F	Yes	APTGLQ40DDA120CT3G

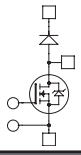
MOSFETs and Super Junction MOSFET Power Modules With SiC Diodes

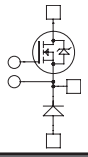
Single Switch + Series FRED and SiC Parallel Diodes



V_{DSS} (V)	MOSFET Type	$R_{DS\ (ON)}$ (mΩ)	I_D (A) T_C = 80°C	Package (see page 20)	NTC	Part Number
1000	MOS 7	65	110	SP6	Option	APTM100UM65SCAVG
1200	MOS 7	100	86	SP6	Option	APTM120U10SCAVG

Power Modules With SiC Schottky Diodes

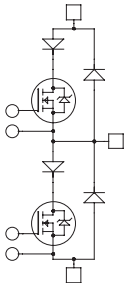




Chopper

V_{DSS} (V)	MOSFET Type	$R_{DS\ (ON)}$ (mΩ)	I_D (A) T_C = 80°C	Package (see page 20)	NTC	...DA... or U2	...SK... or U3
500	MOS 8	65	43	SOT-227	No	APT58M50JCU2	
600	Super Junction MOSFET	45	38	SOT-227	No	APT50N60JCCU2	
		24	70	SP1	Yes		APTC60SKM24CT1G
		18	107	SP4	Yes	APTC60DAM18CTG	
900	Super Junction MOSFET	120	25	SOT-227	No	APT33N90JCCU2	
		60	44	SP1	Yes	APTC90DAM60CT1G	APTC90SKM60CT1G
1000	MOS 8	330	20	SOT-227	No	APT26M100JCU2	APT26M100JCU3
1200	MOS 8	560	15	SOT-227	No	APT20M120JCU2	APT20M120JCU3
		300	23	SP1	Yes	APTM120DA30CT1G	

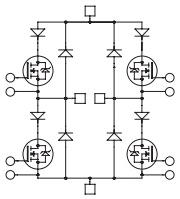
Phase Leg + Series FRED and SiC Parallel Diodes



V_{DSS} (V)	MOSFET Type	$R_{DS\ (ON)}$ (mΩ)	I_D (A) T_C = 80°C	Package (see page 20)	NTC	Part Number
500	MOS 7	38	67	SP4	Yes	APTM50AM38SCTG
		24	110	SP6	No	APTM50AM24SCG
600	Super Junction MOSFET	35	54	SP4	Yes	APTC60AM35SCTG
		24	70	SP4	Yes	APTC60AM24SCTG
		18	107	SP6	No	APTC60AM18SCG
900	Super Junction MOSFET	60	44	SP4	Yes	APTC90AM60SCTG
800		150	21	SP4	Yes	APTC80A15SCTG
		100	32	SP4	Yes	APTC80A10SCTG
		75	43	SP6	No	APTC80AM75SCG
1000	MOS 7	130	49	SP6	No	APTM100A13SCG

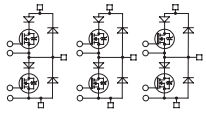
Full Bridge + Series FRED and SiC Parallel Diodes

VDSS (V)	MOSFET Type	RDS (ON) (mΩ)	ID (A) TC = 80 °C	Package (see page 20)	NTC	Part Number
500	MOS 7	75	34	SP4	Yes	APTM50HM75SCTG
600	Super Junction MOSFET	70	29	SP4	Yes	APTC60HM70SCTG
		45	38	SP4	Yes	APTC60HM45SCTG
800		290	11	SP4	Yes	APTC80H29SCTG
900		120	23	SP4	Yes	APTC90H12SCTG
1000	MOS 7	450	14	SP4	Yes	APTM100H45SCTG



Triple Phase Leg

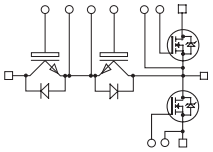
VDSS (V)	MOSFET Type	RDS (ON) (mΩ)	ID (A) TC = 80°C	Package (see page 20)	NTC	Part Number
600	Super Junction MOSFET	24	87	SP6-P	Yes	APTC60TAM21SCTPAG
1000	MOS 7	350	50	SP6-P	Yes	APTM100TA35SCTPG



SiC MOSFET Power Modules

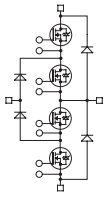
T-Type Three-Level Inverter

VCES (V)	Technology	RDS (ON) (mΩ)	ID (A) TC = 80°C	Package (see page 20)	NTC	Part Number
600/1200	IGBT and SiC MOSFET	110	20	SP3F	Yes	APTMC120HR11CT3AG
		40	50	SP3F	Yes	APTMC120HRM40CT3AG



Three-Level NPC Inverter

VCES (V)	Technology	RDS (ON) (mΩ)	ID (A) TC = 80°C	Package (see page 20)	NTC	Part Number
600	SiC MOSFET	110	20	SP3F	Yes	APTMC60TL11CT3AG
		55	40	SP3F	Yes	APTMC60TLM55CT3AG
		14	160	SP6	No	APTMC60TLM14CAG



Phase Leg

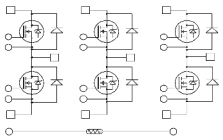
VCES (V)	Technology	RDS (ON) (mΩ)	ID (A) TC = 80°C	Package	NTC	Part Number
1200	SiC MOSFET	55	40	SP1	YES	APTMC120AM55CT1AG
		25	80	SP3F	YES	APTMC120AM25CT3AG
		20	108	SP1	YES	APTMC120AM20CT1AG
		16	102	D3		APTMC120AM16CD3AG
		12	150	SP3F	YES	APTMC120AM12CT3AG
		9	200	SP3F	YES	APTMC120AM09CT3AG
		8	200	D3		APTMC120AM08CD3AG
1700	SiC MOSFET	60	40	SP1	YES	APTMC170AM60CT1AG
		30	80	SP1	YES	APTMC170AM30CT1AG

Phase Leg: Very-Low Inductance Package

VCES (V)	Technology	RDS (ON) (mΩ)	ID (A) TC = 80°C	Package	NTC	Part Number
1200	SiC MOSFET	6.7	210	SP6LI	YES	MSCMC120AM07CT6LIAG
		4.2	307	SP6LI	YES	MSCMC120AM04CT6LIAG
		2.5	475	SP6LI	YES	MSCMC120AM03CT6LIAG
		2.1	586	SP6LI	YES	MSCMC120AM02CT6LIAG
1700	SiC MOSFET	7.5	207	SP6LI	YES	MSCMC170AM08CT6LIAG

Triple Phase Leg

V_{CES} (V)	Technology	$R_{DS\ (ON)}$ (mΩ)	I_D (A) T_C = 80°C	Package (see page 20)	NTC	Part Number
1200	SiC MOSFET	34	55	SP3F	Yes	APTMC120TAM34CT3AG
		33	60	SP6-P	Yes	APTMC120TAM33CTPAG
		17	100	SP6-P	Yes	APTMC120TAM17CTPAG
		12	150	SP6-P	Yes	APTMC120TAM12CTPAG

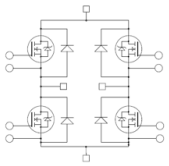


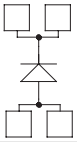
Boost Chopper

VCES (V)	Technology	RDS (on) (mΩ)	ID (A) TC = 80°C	Package (see page 20)	NTC	Part Number
1200	SiC MOSFET	34	50	SOT-227	No	APT50MC120JCU2
		17	100	SOT-227	No	APT100MC120JCU2

Full Bridge

V_{CES} (V)	Technology	$R_{DS\ (ON)}$ (mΩ)	I_D (A) T_C = 80°C	Package (see page 20)	NTC	Part Number
1200	SiC MOSFET	17	110	SP3F	Yes	APTMC120HM17CT3AG



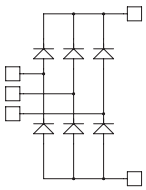


Single Diode

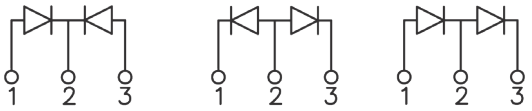
V_{RRM} (V)	Diode Type	I_F (A) T_C = 80°C	V_F (V) T_C = 80°C	Package (see page 20)	
200	FRED	500	1.1	LP4	APTDF500U20G
400		500	1.5		APTDF500U40G
600		450	1.8		APTDF450U60G
1000		430	2.3		APTDF430U100G
1200		400	2.5		APTDF400U120G

Single Diode

V_{RRM} (V)	Diode Type	I_F (A) T_C = 80°C	V_F (V) T_J = 25°C	Package (see page 20)	Part Number
1600	Rectifier	40	1.3	SP1	APTDR40X1601G
		90	1.3	SP1	APTDR90X1601G



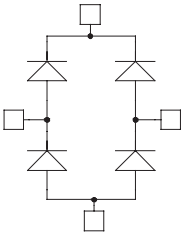
Common Cathode–
Common Anode–Doubler



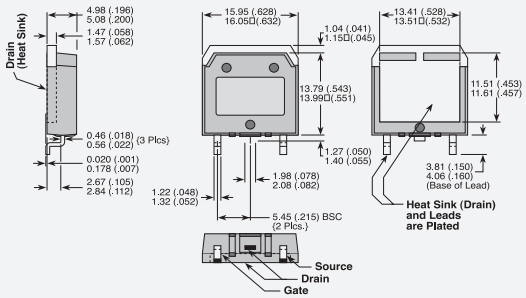
V_{RRM} (V)	Diode Type	I_F (A) per Diode	V_F (V) T_J = 25°C	Package (see page 20)	Common Cathode	Common Anode	Doubler
200	FRED	400	1	SP6	APTDF400KK20G	APTDF400AA20G	APTDF400AK20G
600			1.6		APTDF400KK60G	APTDF400AA60G	APTDF400AK60G
1000			2.1		APTDF400KK100G	APTDF400AA100G	APTDF400AK100G
1200			2.4		APTDF400KK120G	APTDF400AA120G	APTDF400AK120G
1700			2.2		APTDF400KK170G	APTDF400AA170G	APTDF400AK170G

Full Bridge

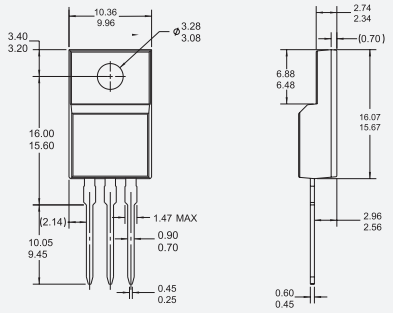
V_{RRM} (V)	Diode Type	I_F (A) T_C = 80°C	V_F (A) T_C = 80°C	Package (see page 20)	Part Number
200	FRED	30	1	SOT-227	APT30DF20HJ
		60	1	SOT-227	APT60DF20HJ
		100	1	SP4	APTDF100H20G
600		30	1.8	SP1	APTDF30H601G
		30	1.8	SOT-227	APT30DF60HJ
		60	1.8	SOT-227	APT60DF60HJ
		60	1.8	SP1	APTDF60H601G
		100	1.6	SOT-227	APT100DL60HJ
		100	1.6	SP1	APTDF100H601G
		200	1.6	SP6	APTDF200H60G
1000		30	2.1	SOT-227	APT30DF100HJ
		100	2.1	SP4	APTDF100H100G
		200	2.1	SP6	APTDF200H100G
1200		30	2.6	SP1	APTDF30H1201G
		60	2.6	SP1	APTDF60H1201G
		75	1.6	SOT-227	APT75DL120HJ
		200	2.4	SP6	APTDF200H120G
1700		50	1.8	SOT-227	APT50DF170HJ
		75	1.8	SOT-227	APT75DF170HJ
1600	RECTIFIER	40	1.3	SOT-227	APT40DR160HJ
		90	1.3	SOT-227	APT90DR160HJ



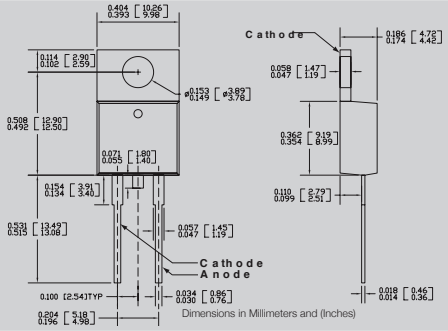
D3PAK
or TO-268



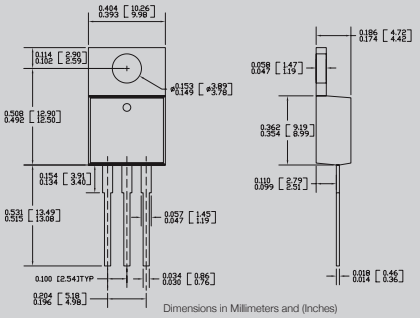
TO-220 [KF]



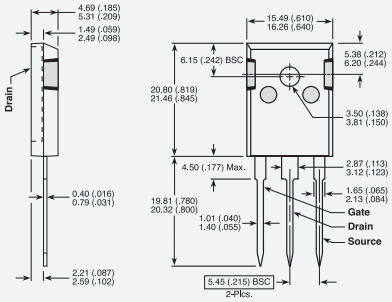
TO-220 2-Lead



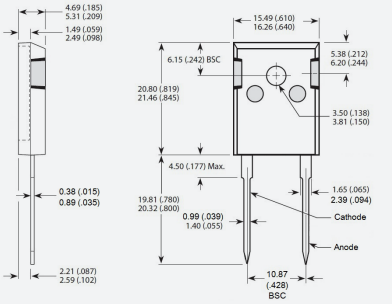
TO-220 3-Lead



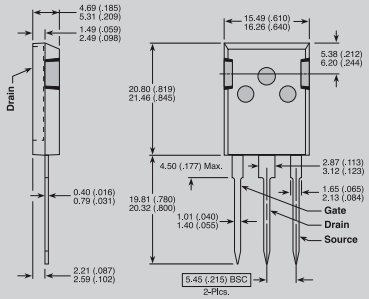
TO-247 3-Lead



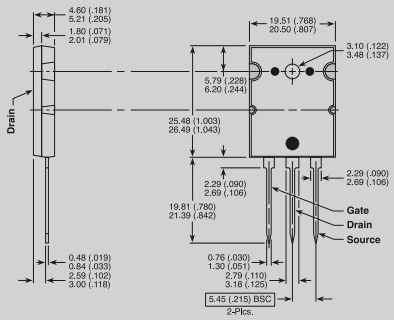
TO-247 2-Lead



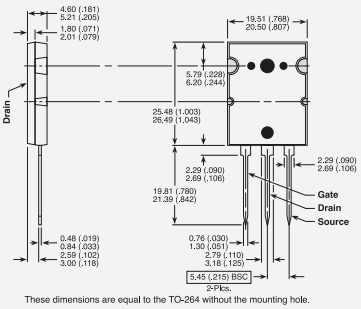
T-MAX®



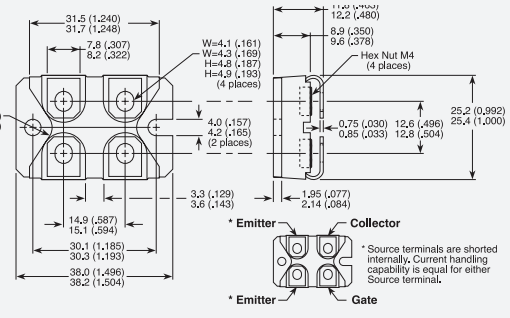
TO-264



264 MAX™



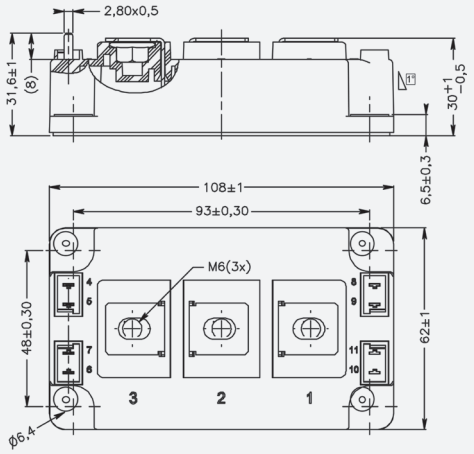
ISOTOP®
or SOT-227



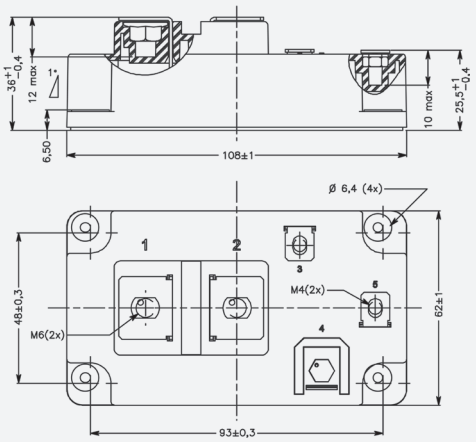
Pinout location depends on the module configuration. Please refer to the product datasheet for pin assignments. All dimensions in millimeters.

Power Module Outlines

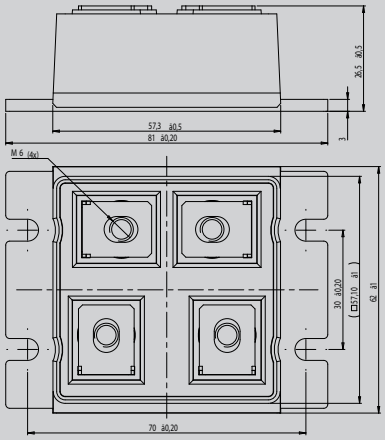
D3PAK



D4



LP4



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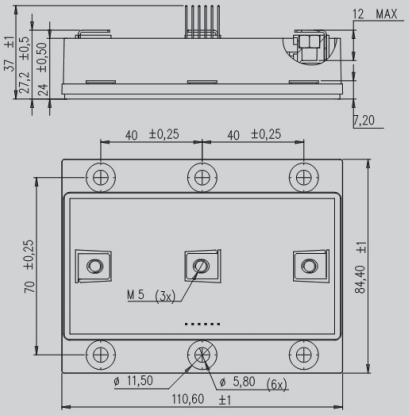
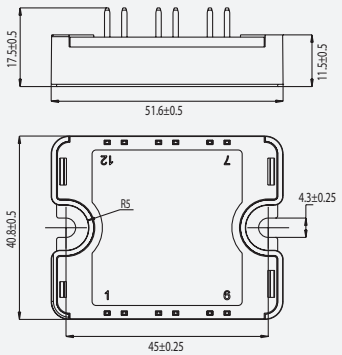
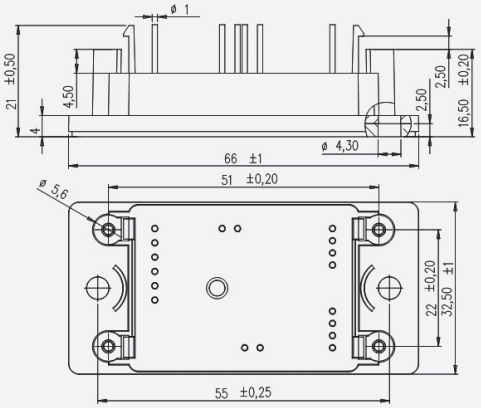


SP1

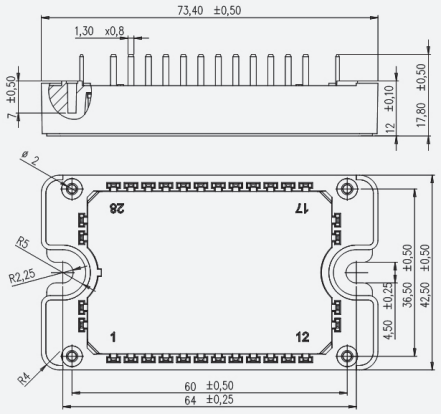


SP2

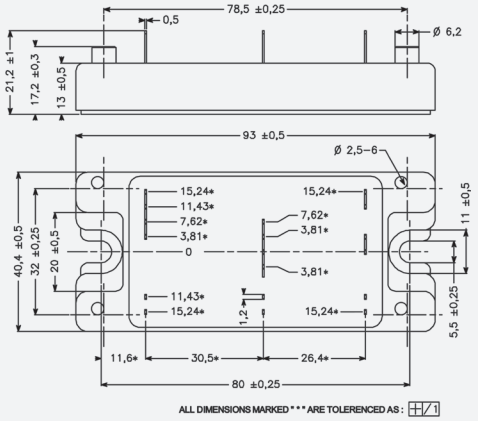


Pinout location depends on the module configuration. Please refer to the product datasheet for pin assignments. All dimensions in millimeters.

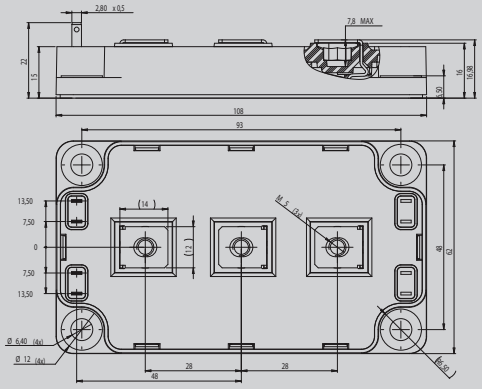
SP3F



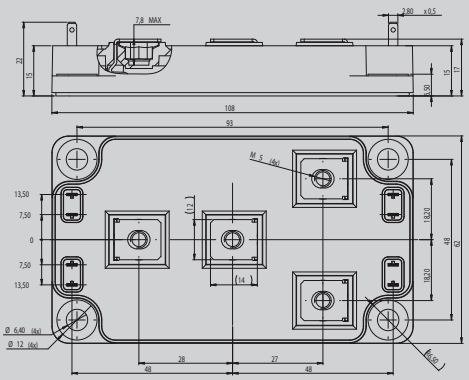
SP4



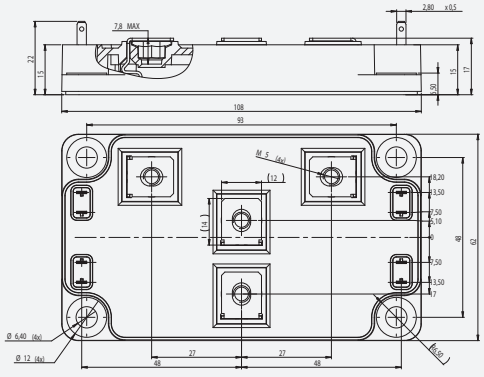
SP6–Three Outputs



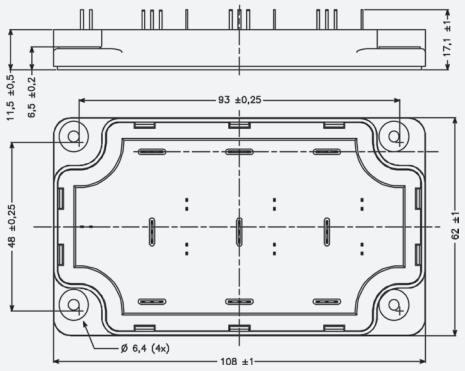
SP6–Four Outputs, Version 1



SP6–Four Outputs, Version 2

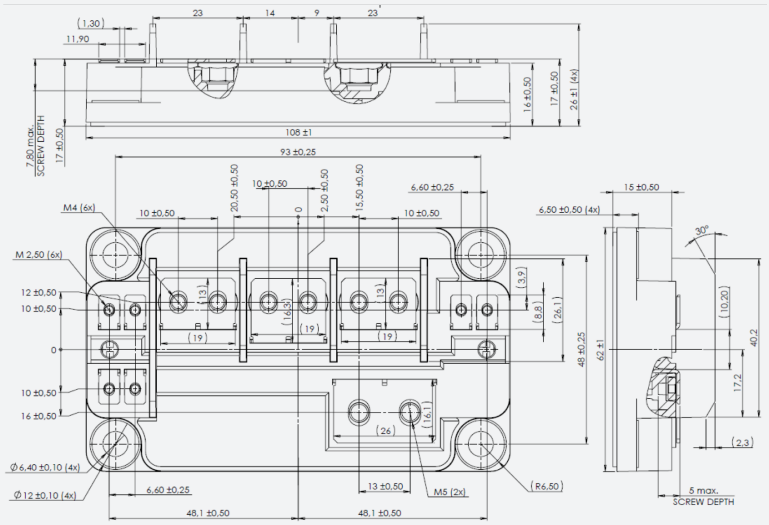


SP6-P

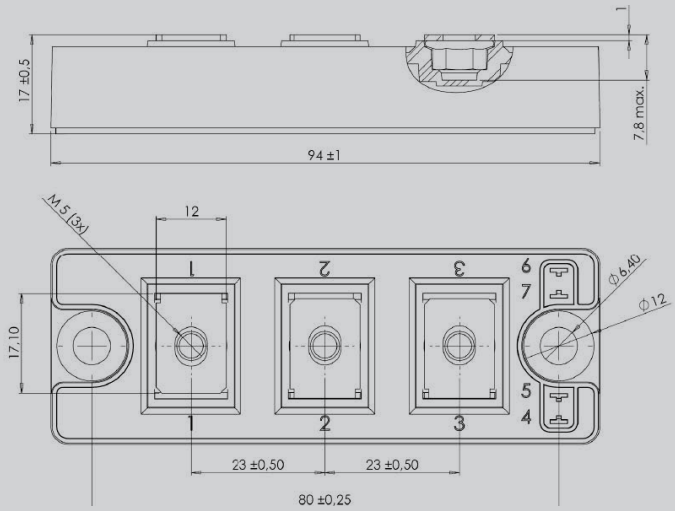


Pinout location depends on the module configuration. Please refer to the product datasheet for pin assignments. All dimensions in millimeters.

SP6LI



D1P



Pinout location depends on the module configuration. Please refer to the product datasheet for pin assignments. All dimensions in millimeters.

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